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SIIP CHINA
SEMI产业创新投资平台

SEMI产业创新投资平台
SEMI Innovation Investment Platform

SEMI产业创新投资平台 - SIIP China是依托SEMI全球产业资源, 汇聚全球产业资本和产业智慧而搭建的专业而权威的产业投融资交流平台。

SIIP China: SEMI产业创新投资论坛是SIIP China全年系列活动之一, 将邀请国家集成电路产业投资基金、01/02专项、地方基金以及产业基金的掌门人以及业界大咖诊断产业现状、把握政策动态、搭建资金平台、预测资金流向、展望行业未来。



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SEMI产业创新投资平台公众号

SEMICON China
FPD China 2020
再相聚

March 18-20, 2020 SNIEC
Shanghai, China

OSS: 2020 年展位预定请到
新国际博览中心内广场, T1与T2之间
(具体位置可参考精彩导读页展位分布图)

* Agenda is subject to change 最新活动议程以现场为准。

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VISITOR GUIDE 观众手册

2019年3月20日-22日 上海新国际博览中心

March 20-22, 2019 SNIEC, Shanghai

主办单位 organizer: 



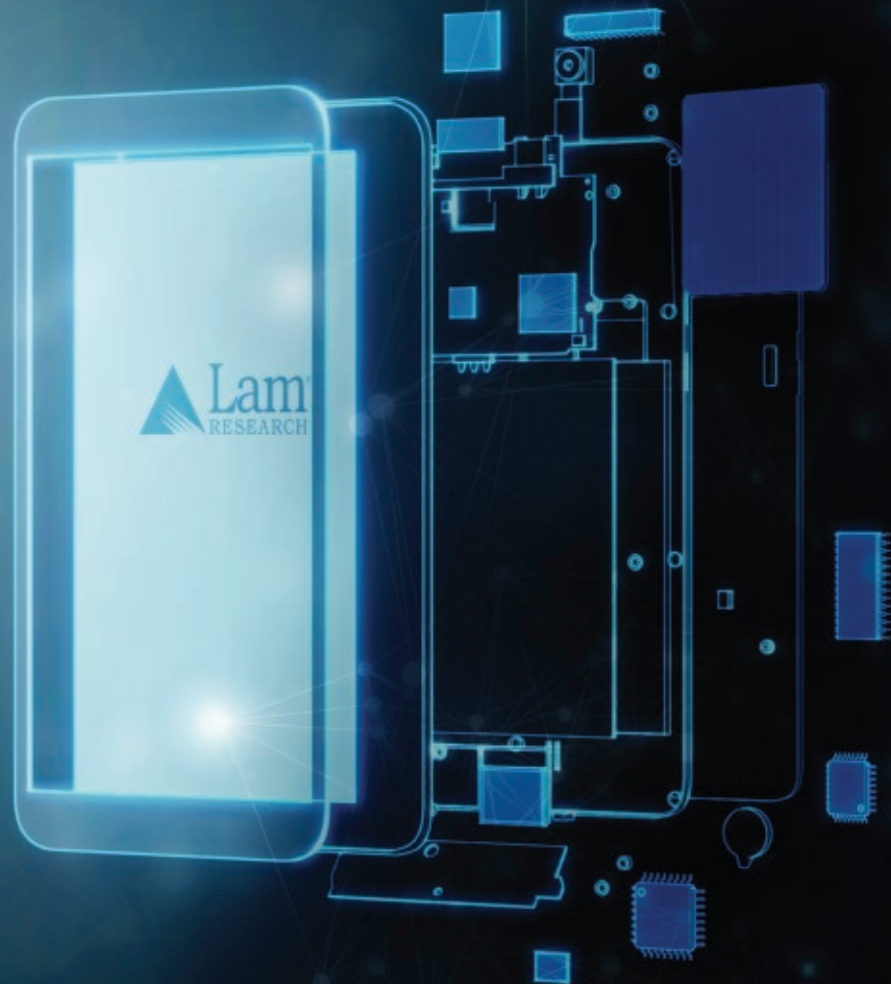
跨界全球 芯芯相联

www.semiconchina.org www.fpdchina.org



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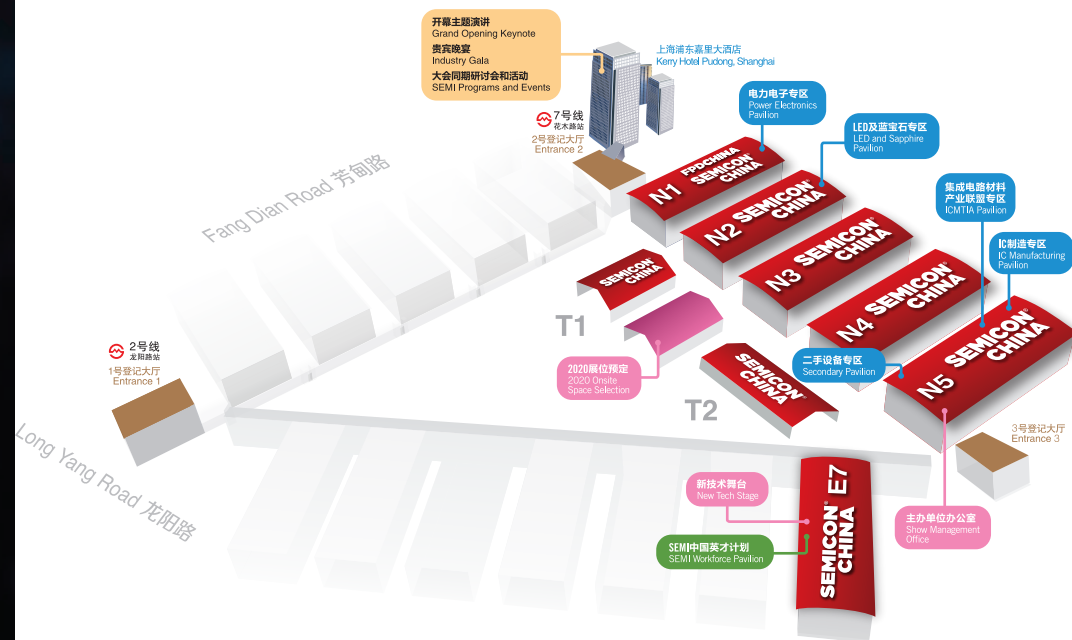


成就客户 创造未来



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展馆分布图 Pavilion Map



欢迎致辞



欢迎来到第三十一届SEMICON China 和FPD China国际半导体展——连续八年全球规格最高、规模最大的半导体“嘉年华”！今年的规模再创历史新高，内容覆盖了最新市场、技术及应用热点，期待您的亲身体验、参与其中。

2018年集成电路诞生60周年，产业增长迅速，是全球经济的重要推手。2018年IC Revenue超过4,700亿美元创新高，2019年市场将回整，但因为AI和5G核心技术的发展，驱动新的智能应用，带动集成电路的需求及成长，所以今后数十年产业会持续成长。

最大规模：SEMICON China 2019展览面积达80,000多平方米，1,200多家展商，4,000多个展位，预计逾10万名专业观众。这是一个覆盖芯片设计、制造、封测、设备、材料供应商等全产业链携手合作，全球规模最大的盛宴！

最高规格：今年的**开幕主题演讲**汇聚了中国及全球顶级行业领袖，来自华虹集团、Applied Materials、Lam Research、Cadence、TEL、Amazon、江苏长电科技等公司的总裁、首席执行官等将畅谈全球产业发展趋势，尤其是AI核心技术趋势及所驱动的创新智能应用。“**SIIP China: SEMI 产业创新投资论坛 2019**”集聚了IC产业基金、企业领袖、全球投资咨询机构的掌门人，今年新增的**电子系统设计 (ESDA) 高峰论坛**将为您剖析AI等新领域设计技术的最新趋势。

聚焦市场热点的技术论坛：“智能汽车”、“智能制造”、“存储器发展论坛”，“功率及化合物半导体国际论坛”、“MSIG人工智能与物联网论坛”、“中国显示大会”等将先进技术与成熟技术创新应用并举。中国国际半导体技术大会 (CSTIC) 更是结合产学研的中国最具影响力的国际微电子技术论坛。

英才计划顺应产业需求：半导体产业的持续健康发展，人才是关键因素。目前人才缺口问题已是全球性的挑战。正是基于此，SEMI中国已成立“SEMI中国英才计划顾问委员会”，保障中国半导体产业的创新力和持续发展动力。今年展会现场还特别开辟了**WFD (英才计划) 专区**，以及展会同期的**SEMI中国英才计划领袖峰会**。

本届展会的主题：**跨界全球·心芯相联**！SEMI的基本主张是自由贸易、开放的市场、知识产权保护和合作共赢，反对设置贸易壁垒，以维护产业的可持续发展。作为帮助实现中国半导体梦想的合作伙伴，SEMI China充分利用独有的国际化合作平台优势，为会员企业及整个产业提供更多的价值。不管任何风云变幻，中国是全球最大的消费电子市场，让我们一起推动中国积极融入全球半导体产业链生态圈，推动产业持续前行！

居龙

SEMI全球副总裁、中国区总裁

Welcome Message

Welcome to the **SEMICON China and FPD China 2019**, the world's largest semiconductor trade show and forum.

We celebrated 2018 as the 60th anniversary of the birth of integrated circuits. IC revenue in 2018 exceeded \$470 billion. Despite the forecasted slow-down in 2019, IC industry is expected to continue growing in the next few decades driven by the many smart applications enabled by the advancement of the core technologies of AI and 5G.

The largest scale: 80,000+ square meters, 1,200+ exhibitors, 4,000+ booths and 100,000 visitors. It covers the whole electronics supply chain.

Top notch leadership-The **Grand Opening Keynote** speeches features world-class industry leaders: President and CEOs from Huahong Group, Applied Materials, Lam Research, Cadence, TEL, Amazon, JCET, who will explore the global business, technology, and market trend. “**SIIP China: SEMI Innovation & Investment Forum**” deliberates innovation, investment, and market hot topics. The new event of **ESDA Executive Panel** will focus on design challenges and solutions of many AI-enabled applications.

Other SEMICON China forums includes “Smart Transportation”, “Smart Manufacturing”, “Memory”, “Power & Compound Semiconductor” “MSIG AI+ IoT” and “China Display Conference”, etc. **CSTIC 2019** continues as the most influential international microelectronics technical conference in China.

Workforce Development- SEMI initiated “**SEMI WFD CHINA Advisory Council**” in 2018 to address the talent gap by attracting and cultivating talents in the China semiconductor industry. **SEMI Workforce Pavilion** and **SEMI Workforce CXO Talent Forum** are the brand-new highlights at SEMICON China 2019.

SEMI's mantra: Connect, Collaborate and Innovate. SEMI's basic principles include free trade, open markets, IP protection, and win-win collaboration to help facilitate the sustainable development of the global electronics industry. SEMI China is committed to serve the China IC industry in continuing growth and integration into the global supply chain ecosystem as a partner. We look forward to an exciting future together!

Sincerely

Lung Chu
President, SEMI China

开幕主题演讲 Grand Opening Keynote

日期Date: 2019年3月20日 星期三 Wednesday, March 20, 2019

时间Time: 12:30 - 16:40

地点Venue: 上海浦东嘉里大酒店, 3楼, 上海厅1 Grand Shanghai Ballroom 1, 3F, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided



Lung Chu 居龙
President, SEMI China
Vice President, SEMI
SEMI全球副总裁、中国区总裁



Ajit Manocha
President & CEO, SEMI
SEMI总裁兼首席执行官



Wang Ning 王宁
President, CECC
中国电子商会会长



Cho Tomoyasu 张智安
VP, China President
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Akihisa Sekiguchi
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Dr. Sarah Cooper
GM Outcome Driven Engineering
Amazon



Gary Dickerson 盖瑞·狄克森
President and Chief Executive Officer
Applied Materials, Inc.
应用材料公司总裁兼首席执行官

SIIP China: SEMI产业创新投资论坛2019 SIIP China: SEMI Innovation and Investment Forum 2019

日期Date: 2019年3月21日 星期四 Thursday, March 21, 2019

时间Time: 09:00 - 16:50

地点Venue: 上海浦东嘉里大酒店, 3楼, 上海厅1 Grand Shanghai Ballroom 1, 3F, Kerry Hotel Pudong, Shanghai

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided



【SEMI产业创新投资平台 - SIIP China】是依托SEMI全球产业资源, 汇聚全球产业资本和产业智慧而搭建的专业而权威的产业投融资交流平台。【SIIP China: SEMI产业创新投资论坛】是SIIP China全年系列活动之一, 将邀请国家集成电路产业投资基金、01/02专项、地方基金以及产业基金的掌门人以及业界大咖诊断产业现状、把握政策动态、搭建资金平台、预测资金流向、展望行业未来。

本次论坛还将围绕深度学习、大数据、云计算、5G和半导体制造展开, 嘉宾们将探讨这些新热点的技术将会对半导体产业带来怎样的巨大变化, 并共同展望中国半导体产业的前景。2018年SEMI完成了对于ESDA的合并, SEMI所覆盖的产业供应链, 及SEMI致力推动的垂直应用平台以及核心技术都由此得以延展和加强, 涵盖了智能交通、智能制造、智能数据、AI、5G以及机器学习等方面。电子系统设计高峰论坛将邀请阿里巴巴、明导科技、新思科技、紫光展锐和南京凯鼎电子的老总们为您剖析电子系统设计的最新趋势。

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Qi Wang 王琦
Cadence全球副总裁及
南京凯鼎电子科技有限公司
总经理

SEMI中国英才计划领袖峰会

SEMI Workforce CXO Talent Forum

SEMI 中国英才计划
SEMI Workforce Development China

日期Date: 2019年3月22日 星期五 Friday, March 22, 2019

时间Time: 09:30-12:40

地点Venue: 上海新国际博览中心, E7馆, SEMI中国英才计划展区 Workforce Pavillion, Hall E7, Shanghai New International Expo Centre

全球半导体和电子制造业在吸引、留住和培养人才方面正面临越来越多的挑战,巨大的人才缺口成为了制约产业发展的关键因素。

为了帮助产业吸引更多的半导体优秀人才,SEMI一直致力于全球推广“英才计划”。该计划旨在与半导体业界以及政府部门通力合作,通过吸引人才、留住人才以及培训人才的方式来保障半导体产业的创新力和持续发展。



Special Thanks



Lung Chu 居龙
SEMI全球副总裁、中国区总裁



Ajit Manocha
President & CEO, SEMI
SEMI总裁兼首席执行官



Leslie Tugman
VP, Global Workforce Development
& Diversity/Executive Director,
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日月光集团副总经理



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泛林集团副总裁兼中国区总经理



Shuji Dinglee 丁术季
杜邦电子与成像集团中国战略
发展总经理



Jessica Chen 陈秋华
Edwards中国区客户中心
人力资源经理

SolutionPartner

Booth No.
N5 5611

LG Chem Semiconductor Materials



功率及化合物半导体国际论坛2019

Power & Compound Semiconductor International Forum 2019

日期Date: 2019年3月21-22日 星期四-星期五 Thursday-Friday, March 21-22, 2019

时间Time: 3月21日 08:30-17:10 3月22日 09:30-16:05

地点: 上海市浦东新区花木路1388号 上海浦东嘉里大酒店浦东厅4 Pudong Ballroom 4, Shanghai Pudong Kerry Hotel

现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided



Day1-Mar.21st, 2019

08:30-09:15	Registration / 注册	Qian Sun 孙钱 Deputy Director, Suzhou Institute of Nano-Tech and Nano-Bionics (SINANO), CAS 中国科学院苏州纳米技术与纳米仿生研究所, 副主任
09:20-09:30	Welcome Remark / 欢迎致辞 Lung Chu 居龙 President, SEMI China SEMI中国, 总裁	
Opening Keynote Speech / 开幕主旨演讲		
	Moderator/主持人: Naiqian Zhang 张乃千 President of Dynax Semiconductor, Inc. 苏州能讯高能半导体有限公司, 总裁	
09:30-10:00	Keynote Speech / 主旨演讲 Andy Chuang 庄渊棋 CEO of Episil 汉磊科技, 总经理	13:30-14:00 Keynote Speech: Using VCSELs in 3D Sensing Applications 用于3D检测的VCSELs技术 Christian Urricariet Senior Director of Global Marketing, Finisar Corporation Finisar Corporation, 全球营销高级总监
10:00-10:30	Silicon Carbide Materials and Devices for Power Switching Applications 用于功率开关应用的碳化硅材料及器件 John Palmour CTO, Wolfspeed Wolfspeed, 首席技术官	14:00-14:25 An EPI AOI System Based on Deep Learning Algorithm for GaN and GaAs 一种基于深度学习算法用于氮化镓及砷化镓外延片检测的AOI检测系统 Aris Ma 马铁中 CEO, AK Optics Technology Co. Ltd 昂坤视觉(北京)科技有限公司, 首席执行官
10:30-11:00	Micro LED: Real Revolution for Display Industry Micro LED: 终极显示技术 Charles Li 李允立 CEO, PlayNitride 鏢创科技, 首席执行官	14:25-14:50 From Si to Compound Semiconductor--EPI Technology and Application in Power Electronic Devices Jun Wu 吴军 Vice President, Naura Technology Group Co., Ltd 北方华创, 副总裁
11:00-11:30	Transforming The Automotive World with Smaller, Lower Cost, More Efficient Power Electronics Stephen Coates VP Global Operations, GaN Systems	14:50-15:15 Compound Semiconductor Power Electronic Devices Manufacturing in Sanan-IC 化合物半导体功率器件制造-三安集成电路 Nien-Tze Yeh 叶念慈 Director of Technology Development, Xiamen Sanan Integrated Circuit Co., Ltd. 厦门三安集成电路有限公司, 总监
11:30-13:30	Break / 休息	15:15-15:30 Break / 休息
*Session: Compound Semiconductor in Optoelectronics, Communications 化合物半导体与光电及5G通讯		
	Moderator/主持人:	15:30-15:55 Compound Semiconductor in Wireless Communication: Opportunities & Challenges 化合物半導體於無線通訊之展望與挑戰 Chuck Huang 黃智文 Associate Vice President, Win Semiconductors

Corp.
穩懋半導體, 協理15:55-16:20 **GaN on Si - A Key Enabling Technology for 5G**
Markus Behet
CMO, EpiGaN
比利时 EpiGaN公司, 首席市场官16:20-16:45 **VCSEL Technology and Applications**
VCSEL 技术及应用James Liu
CEO, Ningbo RaySea Technology Inc, Ltd
宁波睿熙科技有限公司, 首席执行官16:45-17:10 **GaN-A Critical Technology for 5G**
氮化镓 - 实现5G的关键技术
James Huang 黄靖
Sr. Manager, Qorvo
Qorvo, 高级销售经理

Day2-Mar.22nd, 2019

***Session: Wide Band Gap Semiconductors & Emerging Power Devices**

宽禁带半导体及新型功率器件

	Moderator/主持人: David Xiao 肖国伟 CEO, APT Electronics 广东晶科电子股份有限公司, 首席执行官	General manager, Epiworld International Co., Ltd 瀚天天成电子科技(厦门)有限公司, 总经理
09:30-10:00	Keynote Speech: Compound Semiconductors for Connectivity, Sensing, and Energy Wayne Johnson Vice President, IQE IQE, 副总裁	13:30-14:00 New Generation High Power Semiconductor Device Introduction 新世代高功率半導體器件介紹 Henry Yeh 葉時豪 General Manager, Bruckewell Technology Corp., Ltd. Bruckewell Technology Corp., Ltd, 總經理
10:00-10:25	From Market Push to Pull - SiC Transistors Are Leaving The Niche 正在走向更广阔市场的碳化硅晶体管 Peter Friedrichs Senior Director SiC, Infineon Technologies AG 英飞凌科技, 高级总监	14:00-14:25 Development of Gallium Oxide Power Devices 氧化镓功率器件的进展 Kohei Sasaki Senior Manager, Novel Crystal Technology, Inc.
10:25-10:50	High-Voltage Insulated Power Supply and Gate Drive Technology for SiC MOSFETS in Medium/High Voltage Applications 针对中/高压碳化硅MOSFET应用的高绝缘供电驱动技术 Bill Feng 冯恒毅 Executive Vice President, Zhejiang DAIJIN Semiconductor Co., Ltd. 浙江大晶磊半导体科技有限公司, 执行副总	14:25-14:50 8 Inch GaN-on-Si Power Device Manufacturing : Development and Challenges 八英寸硅基氮化镓功率器件制造: 发展与挑战 HanChin Chiu 邱汉钦 Vice President, Innoscience (Zhuhai) Technology Co., Ltd. 英诺赛科(珠海)科技有限公司, 工艺研发副总经理
10:50-11:15	Advances in Plasma Processing for WBG Power Electronics 先进等离子加工技术在宽禁带半导体功率器件中的应用 Aileen O' Mahony Product Manager, Oxford Instruments Plasma Technology 英国牛津仪器, 产品经理	14:50-15:15 Advanced 65nm BCD Offering - Advantages and New Opportunities for Power Management Ics David Misteale Section Head of Power Management R&D, Towerjazz
Closing Keynote / 闭幕演讲		
11:15-11:40	Solutions for Wide Bandgap Power & RF Applications Vincent Meric Senior Product Manager, AIXTRON SE 德国爱思强股份有限公司, 高级产品经理	15:15-15:45 SiC Power Device Technology and Application in Electrified Railway SiC 功率器件技术及其在电气化轨道交通中的应用 Guoyou Liu 刘国友 Vice Chief Engineer, CRRC Zhuzhou Semiconductor 株洲中车时代电气股份有限公司, 副总工程师
11:40-13:30	Break / 休息 Moderator/主持人: Gan Feng 冯淦	15:45-16:05 Lucky Draw 幸运抽奖

先进制造论坛 | Advanced Manufacturing Forum

日期Date: 2019年3月21日 星期四 Thursday, March 21, 2019

时间Time: 09:15-12:00

地点Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

Sponsor					
	Moderator / 主持人: Adam He Ph.D 何新宇 博士 Executive Director, CGP Tech Fund 盛世投资, 执行董事			David Haynes Senior Director of Strategic Marketing, CSBG, Lam Research Corp.	
09:15-09:20	Welcome speech 欢迎致辞	10:35-11:00	Jim Ma 马进武 Director, Qualcomm 美国高通公司, 总监		
09:20-09:45	The Strategic Partner of Semiconductor Industry 做努力奔跑的国产半导体设备追梦者 Peijun Ding 丁培军 President, NAURA北方华创, 总裁	11:00-11:25	Innovation in Semiconductor Manufacturing with Intelligent Control Toshihiko Nishigaki VP & General Manager, Corporate Innovation Division, Tokyo Electron Ltd.		
09:45-10:10	邵华 HLMC, 研发副总裁	11:25-11:50	Closing Keynote Weiran Kong 孔蔚然 HHGrace, EVP 华虹宏力, 执行副总裁		
10:10-10:35	Addressing the Resurgence of 200 mm and >28 nm, 300 mm Capacity Demand Through Technical Innovation and Improvements in Capital Efficiency				

先进封装论坛 - 异构集成

Advanced Packaging Forum - Heterogeneous Integration

日期Date: 2019年3月21日 星期四 Thursday, March 21, 2019

时间Time: 13:00-16:25

地点Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

Sponsor					
	Moderator / 主持人 Dr. Huili Fu 符合利 Senior Technical Advisor, Huawei 华为, 高级技术顾问			开发引领先进半导体封装的湿法蚀刻和清洗液 Dr. Tianniu (Rick) Chen 陳天牛 Vice President of Global SP&C, Versum Materials 慧瞻材料科技, 全球表面清洗和处理副總裁	
13:00-13:10	Welcome and Introduction / 欢迎致辞 Lung Chu 屠龙 President, SEMI China SEMI, 全球副总裁、中国区总裁	14:50-15:00	Break / 休息		
13:10-13:35	Development of Advance SiP Technology and Applications 先进SiP技术的开发和应用 Dr. Steve Liang 梁新夫 Senior Vice President, JCET 江苏长电科技, 高级副总裁	15:00-15:25	Packaging Integration - A Complementary Solution to CMOS Scaling 利用封装集成技术应对CMOS缩微调整 Russell LIU 刘宏钧 Deputy General Manager, WLCSP 苏州晶方半导体, 副总经理		
13:35-14:00	Heterogeneous Product Customization: More than Moore Integration 异构产品定制:超越摩尔的集成方案 Xuewu Gao 高宇武 Corporate Vice President, Mediatek Inc. 聯發科技, 副總經理	15:25-15:50	Heterogeneous Integration for SiP SiP异构集成 Jensen Tsai Director, SPIL 矽品, 总监		
14:00-14:25	New Interconnection in Advanced Packaging - Fan Out 先进封装最新内连接技术——扇外型封装 Oscar Feng 冯耀信 Oscar Feng, Senior Director, ASE 日月光集团, 资深处长	15:50-16:15	Increasing Strategic Relevance of Advanced Packaging for Next-Generation Semiconductor Devices 先进封装对下一代半导体器件开发密切相关 Manish Ranjan Managing Director, Advanced Packaging Customer Operations, Lam research 泛林半导体, 先进封装客户运营, 董事总经理		
14:25-14:50	The development of formulated cleans for enabling packaging processes	16:15-16:25	Closing Remark / 闭幕词		

MSIG人工智能与物联网论坛2019

Brave New World - MSIG Conference on AI+IoT 2019

日期Date: 2019年3月20日 星期三 Wednesday, March 20, 2019

时间Time: 13:00-17:00

地点Venue: 上海浦东嘉里大酒店, 浦东厅4 Kerry Hotel Pudong Shanghai, Pudong Ballroom 4

 现场提供中英文同声传译 Chinese and English Simultaneous Interpretation will be provided

Sponsor					
	Moderator / 主持人 Sean Ding 丁险峰 CTO, IoT BU, Alibaba 阿里巴巴, 物联网部门, 首席技术官			David Butler EVP and General Manager, SPTS SPTS, 执行副总裁和总经理	
13:00 - 13:10	Welcome and Introduction / 欢迎辞 Carmelo Sansone Director of Mems and Sensors Industry Group, SEMI MSIG SEMI MSIG, 总监	15:00 - 15:10	Break / 休息		
13:10 - 13:40	AI needs accurate data - MEMS sensor can provide it MEMS传感器为人工智能提供真实数据 Andrea Onetti Group VP of Analog & MEMS Group, GM of MEMS Sensor Division, STMicroelectronics STMicroelectronics, 模拟&MEMS全球副总裁, MEMS传感器部门总经理	15:10 - 15:35	Inertial Sensors AI应用案例 Ben Lee 李彬 CEO, mCube mCube, 首席执行官		
13:40 - 14:10	Enhanced IoT Edge by Smart Sensors 智能传感器助力IoT边缘智能 Bennini Fouad Regional President Asia Pacific, Bosch Sensortec Bosch Sensortec, 亚太区总裁	15:35 - 16:00	Ultra low power solutions: an ecosystem approach 超低功耗的生态链解决方案 Dr. Carlos Mazure IEEE Fellow, Chairman & Executive Director, SOI Industry Consortium SOI产业联盟, 主席和执行董事, IEEE会士		
14:10 - 14:35	High-Integrity, Fault-Tolerant Open Inertial Measurement Platform for AI-based Vehicle Automation 适用于人工智能车辆自动控制的高集成及容错的惯性测量开放平台 Mike Horton CTO, ACEINNA ACEINNA, 首席技术官	16:00 - 16:25	Horizon AI Processor & Solution, Enable Industries in AI Time 地平线AI芯片解决方案, 赋能千万行业 Carl Zhang 张永谦 General Manager/Vice President, Smart chip solutions division, Horizon Robotics 地平线机器人, 副总裁和智能解决方案与芯片事业部总经理		
14:35 - 15:00	Entering the age of a Trillion Sensors 进入万亿传感器时代	16:20 - 16:50	TBD		
		16:50 - 17:00	Session Summary / 闭幕陈词 Carmelo Sansone Director of Mems and Sensors Industry Group, SEMI MSIG SEMI MSIG, 总监		

存储器发展论坛 | Memory Strategic Forum

日期Date: 2019年3月20日 星期三 Wednesday, March 20, 2019

时间Time: 08:45 - 12:15

地点Venue: 上海浦东嘉里大酒店, 浦东厅4 Kerry Hotel Pudong Shanghai, Pudong Ballroom 4

Sponsor					
08:45-09:15	Registration 来宾登记			Dr. Peijun Ding 丁培军博士 President, NAURA 北方华创, 总裁	
	Moderator / 嘉宾主持 Andrew Peng 彭安 Vice President, Business Development, SPIN MEMORY; Deputy to JEDEC Chairman 副总裁, 业务发展, SPIN MEMORY; JEDEC副主席	10:35-11:00	Scaling of Storage Architecture for the New Data Centric Era Dr. Donghui Lu 卢东晖博士 Sr. Director of Process Development, Sr. Director of Technology and Strategy Office, Intel 英特尔, 存储制程研发中心资深总监, 技术与战略部资深总监		
09:15-09:20	Welcome and Introduction 欢迎致辞				
09:20-09:45	Weihua Cheng 程卫华 VP/CO-CTO, YMTC 长江存储, 副总裁/联席首席技术官	11:00-11:25	Dr. PAN Yang Corporate Vice President, Advanced Technology Development, Lam Research		
09:45-10:10	Scaling Flash Technology to Satisfy Meet Application Demands Shigeo (Jeff) Ohshima 大島 成夫 Technology Executive, SSD Application Engineering, Toshiba 东芝, 执行技术总裁	11:50-12:15	Semiconductor memory technologies: innovations and competitive landscape Dr.Simone Bertolazzi Technology & Market analyst,Yole		
10:10-10:35	NAURA helps memory industry development				

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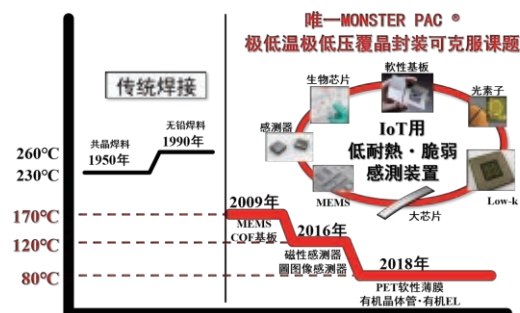
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智能制造论坛 | Smart Manufacturing Forum

日期Date: 2019年3月21日 星期四 Thursday, March 21, 2019

时间Time: 13:00 - 16:40

地点Venue: 上海新国际博览中心E7馆新技术舞台 New Tech Stage ,Hall E7, Shanghai New International Expo Centre

Sponsor



	Moderator / 主持人 Dr. LingZhi Lu 吕凌志 CEO, FA Software(Shanghai) Co., Ltd. 上扬软件(上海)有限公司, CEO	15:05-15:35	Explore Power of Digital Twin with the new Smart Manufacturing DNA Innovation 通过新的智能制造DNA创新,探索数字孪生的力量 许明光 CTO, FA Software(Shanghai) Co., Ltd. 上扬软件(上海)有限公司, 首席技术官
13:00-13:30	Registration		
13:30-13:35	Welcome Speech Tom Salmon VP, Collaborative Technology Platforms, SEMI SEMI, 副总裁	15:35-16:05	Managing Big Data for Smart Manufacturing Doug Suerish Product Evangelist, PeerGroup
13:35-14:05	IBM	16:05-16:35	Keynote: Enable Semiconductor Manufacturing Excellence through China Smart Manufacturing 主旨演讲:借力中国智能制造创建中国半导体卓越制造 Jonathan Chang 张永政 Chief Intelligence Officer, TFME General Manager, TFXM 通富首席智能官, 通富厦门总经理
14:05-14:35	Improving Manufacturing through IKAS Smart Planning, Dispatching and Control—IKAS Semiconductor Smart Manufacturing Solutions MengChu ZHOU 周孟初 Chairman, IKAS Industrial Automation 深圳埃克斯工业自动化, 董事长	16:35-16:45	Lucky Draw 抽奖
14:35-15:05	Reinforcement Factories Matthew Putman CEO, 首席执行官, Nanotronics		

绿色厂务科技论坛 | Green High-Tech Facility Forum

日期Date: 2019年3月21日 星期四 Thursday, March 21, 2019

时间Time: 09:00 - 12:00

地点Venue: 上海新国际博览中心, E7新技术舞台 New Tech Stage ,Hall E7, Shanghai New International Expo Centre

Sponsor



	Moderator 主持人 Kia-Seng Low, PhD 刘加成 Director, ECI Technology, Inc.	10:10-10:35	智慧工厂-厂务智能化解决方案 ZhengChao Jiang 姜峥超 IBM, 绿色地平线事业部项目总监
09:00-9:15	Registration 会议登记注册	10:35-11:00	半导体厂务绿色行动-节能减排 万晨卫 动力部部长, HH Grace 华虹宏力, 动力部部长
09:15-9:20	Welcome Speech 开幕致辞 SEMI		
09:20-9:45	可靠节能与智能化完美结合的供配电保障方案 李清华 总经理, Vertiv Tech Co., Ltd 维谛技术(原艾默生网络能源有限公司), 总经理, 大中华区半导体解决方案部	11:00-11:25	Smart Operation-EcoStruxure help efficient facility maintenance 智 运维-EcoStruxure 助力高效厂务 Jack Zhao 赵天意 Segment Marketing Director, Schneider Electric (China) Co., Ltd 施耐德电气(中国)有限公司上海分公司, 行业市场负责人
09:45-10:10	绿色华星过去与未来 罗洪元 总监, 动力技术处, CSOT 深圳市华星光电技术有限公司, 动力技术处, 总监	11:25-11:50	Chemours 科慕

智能汽车论坛 | Smart Transportation Forum

日期Date: 2019年3月22日 星期五 Friday, March 22, 2019

时间Time: 09:00 - 12:10

地点Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3

Pudong Ballroom 1+2+3, Kerry Hotel Pudong, Shanghai

Sponsor



09:00-09:30	Registration 来宾登记	10:35-11:05	NXP S32 Automotive Processing Platform 恩智浦S32车用处理平台 Gavin ZHANG 张曦 Marketing Director of Automotive Microcontrollers and Processors, NXP Semiconductors 恩智浦半导体, 车用控制器和处理器市场总监
	Moderator / 主持人 Michael Chen 陈少民 Managing Director, HINA 汉能投资董事总经理		
09:30-09:35	Welcome 欢迎致辞 Bettina Weiss VP, 全球副总裁, SEMI	11:05-11:35	Packaging solution for driving smart automotive 驱动智能汽车封装解决方案 Aronson Lin 林少羽 Senior Director, Central Engineering Development & Engineering Integration, ASE Group 日月光集团, 工程整合与客户工程处资深处长
09:35-10:05	Automotive Electronics: Winning Time to Reliability Race 汽车电子:跑赢实现可靠性的竞赛 Lincoln Lee 李立基 PacRim Technical Director, 亚太区技术总监 Mentor, A Siemens Business	11:35-12:05	Georges Andary GM of Bosch Automotive Products (Suzhou) Co., Ltd. Regional President of Bosch Automotive Electronics China 博世汽车部件(苏州)有限公司总经理, 博世汽车电子中国区总裁
10:05-10:35	2030 Electronics of Automotive Mobility Devices Berthold Hellenthal Competence center Electronics and Semiconductors, Semiconductor Strategy - Progressive SemiConductor Program (PSCP), AUDI AG 奥迪汽车	12:05 - 12:10	Lucky Draw 抽奖

2019 新技术发布会 | 2019 New technology release conference

日期Date: 2019年3月20日 星期三

时间Time: 10:00 - 14:30

地点Venue: 上海新国际博览中心, E7新技术舞台Hall E7, Shanghai New International Expo Centre

Sponsor



10:00-10:30	Registration 来宾登记		Moderator / 主持人
	Theme: packaging and test technology 主题:封装测试技术	13:00-13:15	中国科学院微电子所
	Moderator / 主持人	13:15-13:30	Topic: TBD Lei Zhou 周雷 Technical director of China, ATEN ATEN, 中国区技术总监
10:30-10:45	Topic: High Thermal Die Attach for Power & RF 功率和射频器件的高导热芯片粘接解决方案 Dr. Wei Yao 姚伟 博士 Scientific Associate, Henkel Adhesive Technologies - Electronics 汉高电子材料集团, 产品研发经理	13:30-13:45	Topic: Real Time Process Monitoring in CMP, Post CMP Clean Blending and Distribution Applications CMP工艺实时监测与CMP后清洗液的混配和输送应用 Karl Urquhart Chemical Product Technology Manager, PHOCUS-DFS 厦门积分光合作伙伴--美国DFS, 化学品技术经理
11:00-11:15	中国科学院微电子所		
11:15-11:30	Topic: Conference of Huatian "Embedded System in Chip technology" 华天科技"eSinC"集成技术"发布会 Dr. li Ma 马力 Director of advanced package, Huatian Technology (Kunshan) Electronic Co. 华天科技(昆山)电子有限公司, 先进封装研发总监	13:45-14:00	Topic: TBD Phd. TSUTOMU TSUKADA 塚田 勉 Head of technology department, Kanken Techno Co., Ltd. 日本康肯技术有限公司, 技术部 部长
11:30-11:45	Topic: One-Stop ATE Test Platform 一站式ATE测试平台 Jin Pan 潘津 CTO, Suzhou HYC Technology Co., LTD 苏州华兴源创科技股份有限公司, CTO	14:00-14:15	Topic: A Complete Insight on ECD Process Control 全面洞察电化学沉积的过程控制 Dr. Kaz Wikel 卡兹·维基博士 Vice President, Technic, Inc 得力有限公司, 副总裁
11:45-12:00	中国科学院微电子所		
12:00-13:00	Break 休息(午餐自理)	14:15-14:30	Topic: Solvay Material Solution for reducing micro-contamination in Wet processing Equipment 索尔维为湿法制程设备提供有效减少微污染的材料解决方案 Karl Kim Global Marketing Manager for Semiconductor, Solvay Specialty Polymers 索尔维特种聚合物, 半导体市场经理
	Theme: wafer manufacturing and materials technology 主题:晶圆制造及材料技术		

2019 中国显示大会 - 新兴显示论坛

2019 China Display Conference - Emerging Display Forum

日期Date: 2019年3月20日 星期三 Wednesday, March 20, 2019

时间Time: 09:00-17:00

地点Venue: 上海浦东嘉里大酒店, 浦东厅1+2+3 Kerry Hotel Pudong, Shanghai

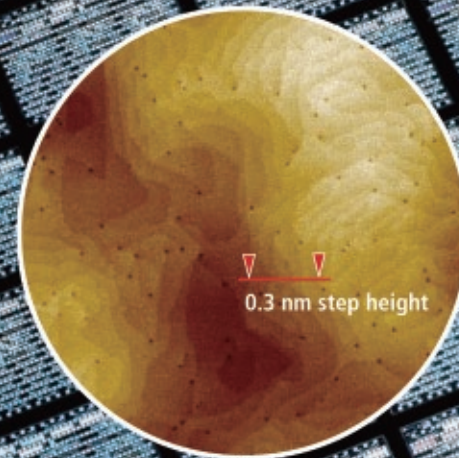
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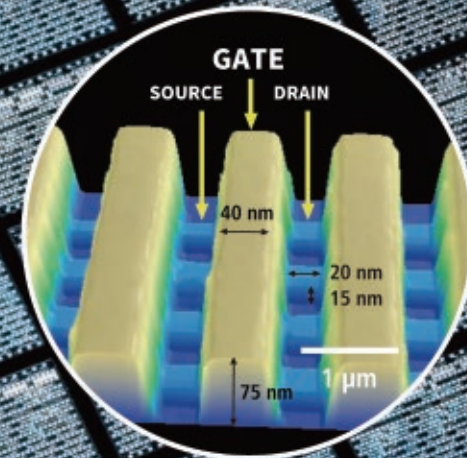
Moderator / 主持人: 严群 SID会士, SID中国区总裁		13:00-13:30	High Resolution Flexible OLED Display Chiwoo Kim 博士 APS Holdings, President & CTO
08:30-09:15	注册 Registration	13:30-14:00	Advanced Classification for Yield Saving and Process Monitoring David Ashiri Regional Product Manager, Orbotech
09:20-09:30	欢迎致辞 Michael Ciesinski SEMI, 全球技术委员会副总裁	14:00-14:30	MicroLED displays are not ready yet, but they may be around the corner Zine Bouhamri Ph.D Technology & Market Analyst, Displays, Yole Développement
	金容爽 SID, 总裁	14:30-15:00	Flexible Micro LED for Displays and Biomedical Applications Keon Jae Lee 博士 韩国科学技术研究院, 教授
09:30-10:00	开幕主旨演讲 Keynote Speech 陈志宏 博士 和辉光电, 副总经理, CTO	15:00-15:30	茶歇 Tea Break
10:00-10:30	Display+ 无限精彩 彭旭辉 天马微电子集团, 副总裁	15:30-16:00	Applied Materials Full Product Suite for Gen 10.5/11 and Advanced TV Manufacturing Isabella Liao Director, Business Unit Operations, Display and Flexible Technology, Applied Materials, Inc.
10:30-11:00	OLED Micro-displays for VR/AR Applications Amal Ghosh 博士 eMagin Corporation, 首席技术官, 资深副总裁	16:00-16:30	The Future Is Flexible - By Laser Rainer Paetzel 美国相干公司, 战略市场总监
11:00-11:30	ALPD激光显示的进展和趋势 李屹 博士 深圳市光峰光电技术有限公司, 总裁	16:30-17:00	Reserved for 3M
11:30-12:00	快速液晶应用技术 郭海成 香港科技大学, 教授		
12:00-13:00	休息 Lunch		

陈志宏 博士
和辉光电, 副总经理,
CTO彭旭辉
天马微电子集团, 副总裁郭海成
香港科技大学, 教授Chiwoo Kim 博士
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AFM image of GaN Flat Substrate



AFM image of 3D FinFET Structure

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2019 Program and Events At a Glance

2019 大会活动一览

Monday Mar 18 周一 3月18日		
08:45-18:30	China Semiconductor Technology International Conference CSTIC中国国际半导体技术大会	Shanghai International Convention Center 上海国际会议中心
Tuesday Mar 19 周二 3月19日		
08:30-17:30	China Semiconductor Technology International Conference CSTIC中国国际半导体技术大会	Shanghai International Convention Center 上海国际会议中心
13:30-17:30	Workforce Development Training Course Advanced Memory Technologies: 3D NAND, DRAM and 3D PCM 先进存储技术: 3D NAND, DRAM and 3D PCM	Shanghai International Convention Center 上海国际会议中心
13:30-17:30	Workforce Development Training Course Package/Advanced Wafer Level Package, System in Package (SiP) and Testing 先进封装技术: 晶圆级封装、系统级封装与测试	Shanghai International Convention Center 上海国际会议中心
Wednesday Mar 20 周三 3月20日		
09:00-17:00	2019 China Display Conference - Emerging Display Forum 2019中国显示大会 - 新兴显示论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:15-12:15	Memory Strategic Forum 存储器发展论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
13:00-17:00	Brave New World - MSIG Conference on AI+IoT MSIG人工智能与物联网论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
13:00-16:45	Grand Opening Keynote 开幕主题演讲	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
17:30-21:00	SEMI Industry Gala(By invitation) SEMI贵宾晚宴 (特邀)	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
10:30-14:45	New Technology Release Conference 新技术发布会	Shanghai New International Expo Centre 上海新国际博览中心
Thursday Mar 21 周四 3月21日		
09:30-16:45	SIIP China: SEMI Innovation And Investment Forum SIIP China: SEMI产业创新投资论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-12:00	Advanced Manufacturing Forum 先进制造论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
13:00-16:50	Advanced Packaging Forum - Heterogeneous Integration 先进封装论坛 - 异构集成	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-17:10	Power & Compound Semiconductor International Forum 功率及化合物半导体国际论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
17:30-19:30	China IC Night - Design Innovation (By Invitation)	
09:30-12:00	Green High-Tech Facility Forum 绿色厂务科技论坛	Shanghai New International Expo Centre 上海新国际博览中心
13:00-16:45	Smart Manufacturing Forum 智能制造论坛	Shanghai New International Expo Centre 上海新国际博览中心
Friday Mar 22 周五 3月22日		
09:00-12:10	Smart Transportation Forum 智能汽车论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:00-17:00	Power & Compound Semiconductor International Forum 功率及化合物半导体国际论坛	Kerry Hotel Pudong, Shanghai 上海浦东嘉里大酒店
09:30-12:40	SEMI Workforce CXO Talent Forum SEMI 中国英才计划领袖峰会	Shanghai New International Expo Centre 上海新国际博览中心
Saturday Mar 23 周六 3月23日		
10:00-19:30	SEMI Golf Tournament(By invitation) “芯球会” SEMICON CHIN高尔夫精英赛 (特邀)	Lake Malaren Golf Club Shanghai 上海美兰湖高尔夫俱乐部



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SEMICON China 2019 Exhibitors List

Company	Booth Hall	Company	Booth Hall
3D-Micromac AG	2481 N2	Beijing CGB Technology Co., Ltd	2251 N2
3M China Ltd.	5561 N5	Beijing Chn-top Optical-Electronic Technology Co., Ltd.	2334 N2
3S Silicon Tech., Inc.	1607 N1	Beijing CR Technology Co., Ltd.	7107 E7
4MSOLUTECH CO., LTD.	T2241 T2	Beijing Doublink Solders Co., Ltd.	2219 N2
A AblePrint Technology Co., Ltd.	4571-4 N4	Beijing E-Town International Investment & Development Co., Ltd	1471 N1
ABM, Inc	1733 N1	Beijing E-Town Semiconductor Technology Co., LTD	5022 N5
Abrolex Science and Technology International Limited.	T1122 T1	Beijing Gerchin Science and Technology Ltd.	T2355 T2
ACCESS Semiconductor Co., Ltd	5713 N5	Beijing Grish Hitech Co., Ltd.	2223 N2
Accuracy Assembly Automation Co., Ltd	4000 N4	Beijing Heqi Precision Technology Inc.	4261 N4
Achilles Corporation	7529 E7	Beijing Huafeng Test & Control Technology Co.,Ltd.	1527 N1
ACM Research (Shanghai), Inc.	5231 N5	Beijing Institute of Automatic Test Technology	4786 N4
ADEKA (China) Co.,Ltd	7263 E7	Beijing Jingyi Automation Equipment Co., Ltd	5665 N5
Adelis Associates Pte Ltd.	4285 N4	Beijing Jingyuntong Technology Co., Ltd	4231 N4
Advance Process Technology, Inc.	2638 N2	Beijing Kaide Quartz Corporation	2227 N2
Advanced Dicing Technologies Ltd	3667 N3	BEIJING KONGLIAN CNC Technology Co., Ltd.	4141 N4
Advanced Energy Industries, Inc., Shanghai	5571 N5	Beijing Longsun Technology Co., Ltd.	2461 N2
Advanced Global Alliance Limited	3275 N3	Beijing NAURA Microelectronics Equipment Co.,Ltd.	3339 N3
Advanced Materials Technology Inc.	T2359 T2	Beijing New Eastech Co., Ltd	5605 N5
Advanced Micro-Fabrication Equipment Inc. China	1014 N1	Beijing Reje Automation Co., Ltd	2257 N2
(ASMC) GTA SEMICONDUCTOR CO.,LTD.	5411 N5	Beijing Sinodynetest Science&Technology Co.,Ltd	4161 N4
Advanced Technology & Materials Co.,Ltd	2309 N2	Beijing TBSTest Technologies Co., LTD	5785 N5
Advanced Technology Co., Ltd	T2301 T2	Beijing Torch Co., Ltd	4107 N4
Advantest (China) Co., Ltd.	4431 N4	Beijing Xiantec Technology Ltd.	2511 N2
AEM Holdings Ltd	T2226 T2	BENEQ OY	7111 E7
Afore Oy	T2226 T2	Bengbu Bright Semiconductor Co., Ltd	1409 N1
AFRISO Measurement&Control Technology (Suzhou) Co., Ltd	T2316 T2	Besi (BE Semiconductor Industries N.V.)	3631 N3
AGVA Technologies Pte Ltd	4800 N4	Best Tech Precision (Dongguan) Co., Ltd.	T1323 T1
AI Technology, Inc.	5483 N5	Bestac Advanced Material Co., Ltd	2186 N2
Aim Systems	T2217 T2	Betone Technology (Shanghai), Inc.	4181 N4
AIR LIQUIDE China Holding Co., Ltd.	5008 N5	Better Pure Material Ltd	T2227 T2
Air Products and Chemicals (China)	7022 E7	B-Horizon GmbH	2678 N2
AK Tech Co., Ltd.	7555 E7	B-Horizon GmbH	2676 N2
Akribis Systems (Shanghai) Co.,Ltd	1541 N1	BISTEL,Inc	7748 E7
All Ring Tech Co.,Ltd	7706 E7	BKB Precision	2665 N2
Allied Supreme (Jia Xing) Corp.	2816 N2	BMT Co., Ltd.	T2173 T2
Allround Trading (Shanghai) CO., Ltd.	3008 N3	Bonotec Electronic Materials Co., Ltd.	7808 E7
Alltek Company	3331 N3	Boschman Technologies B.V.	2667 N2
Allwin21 Corporation	4180 N4	Brewer Science, Inc.	2608 N2
AM Technlogy Co., Ltd.	5318 N5	Brooks Automation, Inc.	4381 N4
Amaya Co., Ltd.	1617 N1	Bruker (Beijing) Scientific Technology Co., Ltd	7765 E7
American Tec Co. Ltd	3283 N3	Bueno Technology Co., Ltd.	3177 N3
AMFLO Fluid System & Components Co., Ltd.	1722 N1	Bukwang Tech Co., Ltd.	7319 E7
Anhui Argosun New Electronic Material Co., Ltd	2289 N2	C.H. Robinson Freight Services (China) Ltd.	T1206 T1
Anhui Botai Electronic Materials Co., Ltd	5160 N5	Cabot Microelectronics Corporation	3271 N3
Anhui Dahua Semiconductor Technology Co., Ltd	7181 E7	Camtek HK Ltd.	2487 N2
Anji Microelectronics(Shanghai)Co.,Ltd.	5351 N5	Canon Machinery Inc.	3820 N3
ANZ Company	T1126 T1	Carl Zeiss Far East Co., Ltd.	2619 N2
AP&S International GmbH	2579 N2	centrotherm clean solutions GmbH & Co. KG	2784 N2
APIC YAMADA CORPORATION	2451 N2	centrotherm international AG	3014 N3
Applied Nano Technology Science, Inc.	1739 N1	CETC Electronics Equipment Group Co., LTD	3471 N3
Applied Seals Co., Ltd.	T1317 T1	Challentech International Corporation	2826 N2
ARCS Precision Technology Co, Ltd.	2145 N2	ChangChun GuangHua Micro-Electronics Equipment Engineering Center Co., Ltd.	4323 N4
Asahi Diamond Industrial Co., Ltd.	2141 N2	Changsha Hi-Test Intelligent Equipment Co., Ltd	1513 N1
ASAHI YUKIZAI CORPORATION	7654 E7	Changzhou Changyao	2138 N2
ASFLOW Co., Ltd.	4176 N4	Changzhou Ruize Microelectronics Co., Ltd	2374 N2
ASM Technology Singapore Pte. Ltd.	3445 N3	Chart Automation System Co., Ltd	4471 N4
Astronics Technologies Private Ltd	2744 N2	Cheng Tay Heater & Instrument Co., Ltd	3158 N3
ASV Stuebbe Pumps & Valves (Suzhou) Co., Ltd.	T2174 T2	Chengdu Apex New Materials Co., Ltd	T2130 T2
ATC Co., Ltd.	5105 N5	Chengdu Laipu Science & Technology Co., Ltd	2189 N2
Athlete FA Corporation	3134 N3	Chengdu Shangming Industrial Co., Ltd	1561 N1
ATI Korea Co., Ltd.	4759 N4	Chengdu Yeheng Electronic Co., Ltd	4144 N4
ATI Korea Co., Ltd.	4737 N4	China Electronic Market	T2152 T2
Atlas Copco (Shanghai) Trading Co., Ltd	7166 E7	China Electronic Production Equipment Industry Association	4240 N4
Atlas Technology Corporation	2561 N2	China Electronics Materials Industry Association	T1437 T1
Atotech (China) Chemicals Ltd.	5325 N5	China Electronics System Engineering No.2 Construction Co.,Ltd	5112 N5
ATT Systems GmbH	2674 N2	China Fortune Land Development Co., Ltd.	1501 N1
Auzhan Electrothermal Technology Co., Ltd	T1124 T1	China Integrated Circuit	T2135 T2
AW (Shanghai) Metrology & Testing Technology Co., Ltd.	T1111 T1	China Semiconductor Industry Association	T2162 T2
Baoding North Special Gas Co., Ltd	5285 N5	China Silicon Corporation Ltd.	7523 E7
Baud Technology Shanghai Co., Ltd.	4425 N4	China Wafer Level CSP Co., Ltd	5501 N5
BCnC CO., LTD	7329 E7	Chongqing ZhenBao Industry Co., Ltd	5189 N5
Be First Technology Co., Ltd.	3659 N3	Chroma ATE Inc.	3171 N3
Beijing Asia Science & Technology Co., Ltd	4371 N4	CHUKOH Chemical (Shanghai) Trading., Ltd	T1212 T1
Beijing BBF Science&Technology Co., Ltd.	T2148 T2		
BEIJING BEIYI WOOSUNG VACUUM TECHNOLOGY CO., LTD	4242 N4		

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SEMICON China 2019 Exhibitors List

Company	Booth	Hall	Company	Booth	Hall
Chung King Enterprise Co.,Ltd	2167	N2	EQ Tech Plus Co., Ltd	T2160	T2
CHYI DING Technologies Co., Ltd.	1753	N1	ERS Electronic GmbH	4386	N4
Cica-Huntek Chemical Technology Taiwan Co., Ltd.	7657	E7	ESCS Co., Ltd-Taiwan Branch	T1231	T1
Cimetrix Incorporated	4284	N4	E-Tech Solution Co., Ltd.	4185	N4
CIR-LOK Fluid Equipment Chengdu Co.,Ltd	5703	N5	Europe-China Electronic Materials Co., Ltd	T2113	T2
CIS Corporation	4140	N4	EV Group (EVG)	2547	N2
CKD Corporation	2301	N2	Evatec AG	3251	N3
CM TECH Co., Ltd.	5229	N5	EVER RED NEW TECHNOLOGY CO. LTD	7663	E7
CNI Technology, Inc.	5302	N5	Ever Team International Corp.	3122	N3
CohPros International Co., Ltd	2371	N2	Everlight Chemical Industrial Corporation	2627	N2
COMA Technology Co., Ltd.	5322	N5	Evertech Enterprise Co., Ltd.	T1408	T1
COMET Mechanical Equipment (Shanghai) Co. Ltd.	2439	N2	EXICON Co., Ltd	T2267	T2
Component Technology Pte., Ltd.	2635	N2	Exis-Tech Sdn Bhd	7419	E7
Compound Semiconductors China/Silicon	T2131	T2	Exyte (M+W Shanghai).	1022	N1
Semiconductor China			F&K Delvotec Bondtechnik Singapore Pte Ltd	3219	N3
Conax Technologies	2545	N2	FA Software (Shanghai) Co., Ltd	5467	N5
Corad Technology, Ltd.	4820	N4	Fantron Technologies (Shanghai) Co. Ltd.	4227	N4
C-Pak Electronic Packaging(Suzhou) Ltd.	5123	N5	FCT (Tangshan) Technical Ceramic Industry Co., Ltd	T2109	T2
CPS Europe Ltd	T2154	T2	Feinmetall OCT Ltd.	5737	N5
CR GEMS Superabrasives Co., Ltd.	T1136	T1	Finetech GmbH & Co. KG	2672	N2
Creative Technology (Shanghai) Co., Ltd	4741	N4	First Technology China Ltd.	3617	N3
Crest Systems (Suzhou) Co., Ltd.	2761	N2	FISCHER INSTRUMENTATION LTD	7123	E7
CS CLEAN SOLUTIONS AG	4812	N4	Fitok Incorporated China	7334	E7
CSE Co., Ltd.	5585	N5	Fittech Co., Ltd	5371	N5
CXsemi Company Limited	T2337	T2	Flagship International Ltd.	4339	N4
Cycad Century Science&Technology Ltd.	2567	N2	Flowell Corporation	7653	E7
DAESHIN MC CORPORATION	T1132	T1	FNS, Inc.	7729	E7
Dalian High Purity Chemical Co., LTD	5601	N5	Focused Test, Inc.	4651	N4
Dalian Jafeng Automation Co.,Ltd	3387	N3	Foosung Precision Industry Co., Ltd. Fluoropolymer	7223	E7
Dalian Linton NC Machine Co., Ltd.	1651	N1	Division		
Dalian Shungji Technology Industry Co., Ltd	7501-1	E7	FORM	T2115	T2
Dalian Zhongding Chemicals Co., Ltd.	2157	N2	Form Factor Inc.	4625	N4
Dandong Aolong Radiative Instrument Group Co.,Ltd	4320	N4	Fortive Setra-ICG (Tianjin) Co., Ltd	T2266	T2
Dandong Liaodong Radioactive Instrument Co., Ltd	4139	N4	FTDevice Technology(Suzhou) Co.,Ltd	5675	N5
Dandong Xin Dongfang Crystal Instrument Co., Ltd.	4417	N4	Fugen Co., Ltd	5326	N5
DAS Environmental Expert GmbH	2631	N2	Fujian Yongjing Technology Co., Ltd.	5234	N5
Dasan Eng Co., Ltd	5755	N5	Fujikin Incorporated	3000	N3
DCSENG CO., LTD.	5310	N5	Fuzhou Palead Electronics Technology Co., Ltd	7619	E7
Denair Energy-Saving Technology (Shanghai) Stock Co., Ltd	4238	N4	Galaxy Technology Development Company	2144	N2
Denton Vacuum, LLC	T2149	T2	Gastron Co., Ltd.	7725	E7
DF Tech	4683	N4	GAT Transmission Technology (Beijing) Co.,Ltd	T1224	T1
DI Corporation	4281	N4	Gemch Material Technology (Suzhou) Co., Ltd	T2164	T2
Ding Cheng International Co., Ltd	T1407	T1	Gemu Valves (China) Co., Ltd.	3231	N3
DISCO HI-TEC CHINA CO., LTD.	3401	N3	Genes Tech Co., Ltd.	7335	E7
DKSH (Shanghai) Ltd	7671	E7	Genesem Inc.	5306	N5
DNIV Int'l Pte Ltd	7632	E7	Georg Fischer Piping Systems Ltd.,	1419	N1
Do-FluoRIDE CHEMICALS Co., LTD	5681	N5	German Federal Ministry of Economics and Technology	2571	N2
Dong Rong Electronics Co., Ltd.	7307	E7	GI Tech Co., Ltd	T1223	T1
Dongfang Jingyuan Electron Limited	1708	N1	Global Precise Instrument Corporation	7636	E7
Dongguan C.C.P. Contact Probes Co., Ltd	7173	E7	Glory Technology Corp.	7635	E7
DongGuan Haye automation Equipment Co., Ltd	1709	N1	Gore Industrial Products Trade (Shanghai) Co., Ltd	1461	N1
Dongguan Wintime Electronic Co., Ltd	3707	N3	Grace Haozan Applied Material Co., Ltd	4806	N4
Dongjin Semichem Co., Ltd.	4609	N4	Grandmake Technology Ltd	7234	E7
Dongwoo Fine-Chem Co., Ltd.	2183	N2	GreenFILTEC TAIWAN LTD.	T2343	T2
Dou Yee Electronic Technologies (Nanjing) Ltd	T2347	T2	Grikin Advanced Materials Co., Ltd.	2431	N2
Dou Yee Enterprises (S) Pte Ltd	4022	N4	Groz-Beckert KG	2677	N2
DR. JOHANNES HEIDENHAIN (CHINA) Co., Ltd.	2331	N2	GTA Material Co., Ltd.	4571-1	N4
DS Fibertech Corporation	2507	N2	Guang Dong SUOREC Technology Co., Ltd	2467	N2
Dwyer Instruments HK, Ltd.	T1239	T1	Guangdong CRC Cleanroom System Co., Ltd	7559	E7
Dymek Company Ltd.	2557	N2	Guangdong Leadyo IC Testing Co., Ltd.	5537	N5
E and R Engineering Corporation	7101	E7	Guangxi Guixin Semiconductor Technology Co., Ltd.	5401	N5
EAG laboratories	2563	N2	Guangzhou MediaComm Technology Co., Ltd.	T1436	T1
ebm-papst Ventilator (Shanghai) Co., Ltd.	T2155	T2	Gudeng Precision Industrial Co., Ltd.	2808	N2
ECI Technology Inc.	5127	N5	Gui Lin LDAB Semiconductor Equipment Co.,Ltd	7407	E7
Economic Development Partnership of North Carolina	T1236	T1	Haiyan Klean Tubing Co., Ltd	7749	E7
EFAB International Technology Co., Ltd.	2340	N2	Hakuto Enterprises (Shanghai) Ltd.	2551	N2
EGMO Co., Ltd.	1619	N1	Hamai Co., Ltd.	1545	N1
Elemental Scientific, Inc.	7755	E7	HAMAMATSU PHOTONICS K.K.	T2122	T2
EN Semiconductor (Shanghai) Inc	7143	E7	Ham-let (Israel-Canada) Ltd.	1627	N1
Enam Optoelectronic Material Co., Ltd	1707	N1	Hangzhou Anow Microfiltration Co., Ltd	2135	N2
Engis (Hong Kong) Ltd	1716	N1	Hangzhou Changchuan Technology Co.,Ltd	5141	N5
Enplas Electronics (Shanghai) Co., Ltd Suzhou Branch	T1118	T1	Hangzhou Cobetter Filtration Equipment Co., Ltd.	2401	N2
Entegris (Shanghai) Microelectronics Trading Co., Ltd.	5331	N5	Hangzhou Darily Filtration Equipment Co., Ltd.	T1238	T1
EO Technics Co., Ltd.	3625	N3	Hangzhou Deefine Filtration Technology Co., Ltd	2306	N2
ePAK International, Inc.	3812	N3	Hangzhou Jingxin Chemical Co., Ltd	T2229	T2
EpiValence Ltd	T1438	T1	Hangzhou Sizone Electronic Technology Inc.	1706	N1
			Hanking Electronics (Liaoning) Co., Ltd	3209	N3

SEMICON China 2019 Exhibitors List

Company	Booth	Hall	Company	Booth	Hall
HANMI Semiconductor	3437	N3	Intertec Sales Crop Shanghai Rep office	T2212	T2
Han's Photoelectric Equipment Co.,Ltd.	3583	N3	inTEST Corporation	3351	N3
Hansol Chemical Co., Ltd.	7771	E7	IREA TECH	T2136	T2
Hanyang ENG Co., Ltd.	7423	E7	IS Sealing Solutions Co.,Ltd	T1317	T1
Hanyung Corporation	5215	N5	ISC Co., Ltd	4775	N4
Harbin Aurora Optoelectronics Technology Co., Ltd.	2175	N2	ISRA VISION AG	7008	E7
Harmonic Drive Systems (Shanghai) Co., Ltd	T2165	T2	ITI	5211	N5
Harvest Electronic Technology Co., Ltd	5820	N5	Iwaki Pumps (Shanghai) Co., Ltd	3144	N3
Hauman Technologies Corporation	3371	N3	J.E.T. Co., Ltd	7301	E7
Hebei Poshing Electronics Technology Co., Ltd.	5111	N5	JAPAN CREATE Co., Ltd.	7577	E7
Hefei Chip Foundation Micro-Electronics Equipment Co., Ltd	7323	E7	Japan Electronic Materials Corporation	4733	N4
			JAPAN FINE CERAMICS CO.,LTD (JFC)	7650	E7
Hefei ImagEx Electronics Technology Co., Ltd.	5104	N5	JEL CORPORATION	2257	N2
Henan Keen Superhard Materials Technology Co., Ltd.	2222	N2	JEOL Ltd.	2634	N2
Henan Union Precision Material Corp. Ltd.	2703	N2	JHT Design Co., Ltd.	7413	E7
Henan Xinlianxin Shengle Energy Co., Ltd	T1137	T1	Jiangsu Advanced Material Technology & Engineering Inc.	T2167	T2
Henkel Loctite (China) Co., Ltd.	5631	N5	Jiangsu Aulfirst Material Technology Co., Ltd	1656	N1
Heraeus Materials Technology Shanghai Ltd.	7459	E7	Jiangsu Changjiang Electronics Technology Co., Ltd	5014	N5
Heraeus Noblelight China	7459	E7	(JCET)		
Heraeus Shin-Etsu Quartz China Inc.	7459	E7	Jiangsu Denoir Technology Co., Ltd	T1102	T1
Hermes-Epitax Corp.	3431	N3	Jiangsu Eastone Technology Co., Ltd	7601	E7
Hero Fair Limited	3483	N3	Jiangsu Hengtong Intelligent Technology Co., Ltd	T2117	T2
Hicon Co., Ltd	7753	E7	Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.	2589	N2
Hitachi Chemical (Shanghai) Co., Ltd.	3287	N3			
Hitachi Power Solutions Co.,Ltd.	2737	N2	Jiangsu Leadmicro Nano-Equipment Technology Ltd.	1611	N1
HITEC Power Protection B.V.	2764	N2	Jiangsu Leuven-Instruments Co., Ltd	2775	N2
Hiwini Mikrosystem Corp.	4409	N4	Jiangsu Nata Opto-electronic Material Co., Ltd.	2245	N2
HLMC	5443	N5	Jiangsu Pacific Quartz Co.,Ltd.	5471	N5
Hojeonable Inc.	T2308	T2	JIANGSU SHENZHOUS SEMI TECHNOLOGY CO., LTD	7146	E7
Hokuriku Machinery Trading (Suzhou) Co., Ltd	2721	N2	Jiangsu Woze. Inc	7130	E7
Homwell International Trade (Shanghai) Co., Ltd.	4151	N4	Jiangsu Xinhua Semiconductor Material Technology Co., Ltd	7469	E7
Honda Electronics Co., Ltd.	7745	E7			
Honeywell	7571	E7	Jiangsu Xinhua Semiconductor Material Technology Co., Ltd	5365	N5
Hongke Technology Co., Ltd	T1325	T1			
Hongzhunda Electronic Technology (Changzhou) Co., Ltd	T1308	T1	Jiangsu Yoke Technology Co., Ltd	1451	N1
HORIBA, Ltd.			Jiangsu Zhongke Xinyuan Semiconductor Co., Ltd	7463	E7
Hong Terng Automation Co., Ltd.	5176	N5	Jiangyin Chemical Reagent Factory Co., Ltd	5585	N5
HPC Trading (Shanghai) Co., Ltd.	3022	N3	Jiangyin Jianghua Microelectronic Materials Co., Ltd	5155	N5
HPC Trading (Shanghai) Co., Ltd.	3601	N3	Jiangyin Runma Electronic Material Co., Ltd	5267	N5
HPWK Machine	2155	N2	Jilin Huiheng Electronic Technology Co., Ltd	4221	N4
ht tech	5589	N5	Jim & Steve Industrial Co., Ltd.	3759	N3
Hua Hong Semiconductor (Wu Xi) Limited	5447-2	N5	JinZhou East Quartz Material Co., Ltd.	2381	N2
Huate Gas Co.,Ltd	5261	N5	JINZHOU NEW CENTURY QUARTZ GLASS CO.,LTD	5281	N5
Hubei Dinghui Microelectronics Materials Co., Ltd	T2201	T2	Jipal Corporation	3101	N3
Hubei Feilihua Quartz Glass Co., Ltd.	4601	N4	Join Technology Co., Ltd.	4140	N4
Hubei Sinophorus Electronic Materials Co., Ltd.	5361	N5	J-solution	7732	E7
Humbert Electronic Science&Technology (Suzhou) Co., Ltd.	2008	N2	JSR Corporation	5271	N5
			JT Corp.	5138	N5
HUNAN STCERA CO.,LTD	3210	N3	JULABO GmbH	2782	N2
Hung-Jou Technology., Ltd.	7734	E7	Junkosha Inc.	T2327	T2
Huzhou Dong ke Electron Quartz Co, Ltd.	7766	E7	Justin BD&L, Inc.	5300	N5
HUZHOU OPAL QUARTZ TECH CO., LTD	T2132	T2	JUSUNG Engineering Co., Ltd.	7251	E7
Huzhou Veecod Opto-Technology Co., Ltd.	5204	N5	JYE YEU ENTERPRISE Co., Ltd	T1337	T1
Hwashu Technology (Shanghai) Co., Ltd.	3737	N3	Kajio Semiconductor Technology (Shanghai) Co., Ltd	T1113	T1
HWatsing Technology Co., Ltd	4659	N4	Kanematsu Corporation	7154	E7
Hyundai BC Engineering Co., Ltd	5770	N5	Kanken Techno Co., Ltd.	5637	N5
Hywng Technology Limited	7008	E7	Kanamax Japan Incorporated	T1305	T1
ICAM Engineering Limited	T1438	T1	Kashiyama Industries,LTD.	T1439	T1
Ichor Systems Ltd	T2154	T2	KBTEM-OMO JSC	5721	N5
ICS Technology Co., Ltd.	5122	N5	KC Tech Co., Ltd.	5319	N5
IEEE Xplore Digital Library	5715	N5	KCC Corporation	7435	E7
IL SINNEO Co., Ltd	5227	N5	KDF	2322	N2
Industrial Tools, Inc.	3739	N3	KE Semiconductor Equipment (Shanghai) Co., Ltd.	2000	N2
INFICON Limited	2658	N2	Kematek (Suzhou Key Materials Technologies Co., Ltd.)	5824	N5
Inner Mongolia Ojing Science&Technology Co., Ltd	7231	E7	Kempur Microelectronics, Inc.	5355	N5
Inno Global Inc.	4804	N4	Kesite Instruments (Dandong) Co., Ltd.	4223	N4
Innolas Semiconductor GmbH	7008	E7	Keyence (China) Co., Ltd	2279	N2
Innores Co., Ltd.	5206	N5	Kinergy Corporation Ltd.	2734	N2
Institute Of Microelectronics of Chinese Academy of Sciences	5301	N5	King Long Technology (Suzhou) Limited	5531	N5
Institute Of Optics And Electronics Chinese Academy Of Sciences	4316	N4	KINGSEMI CO., LTD	3201	N3
Integrated Dynamics Engineering GmbH	T2147	T2	Kingyup Enterprises Co., Ltd.	5107	N5
Integrated Plasma Inc	2384	N2	KITA Manufacturing Co., Ltd.	T2225	T2
Integrated Technology Corporation (ITC)	4800	N4	KITZ SCT CORPORATION	2022	N2
INTEKPLUS Co., Ltd.	7535	E7	KLA Corporation	5134	N5
			K-Max Technology Co., Ltd.	7169	E7
			KNG-TECH (SHANGHAI) CO., LTD	5676	N5
			Knight Auto Precision Engineering Pte Ltd	3808	N3

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Kojima Instruments Shanghai Inc.	1616	N1	MUJIN ELECTRONICS Co., Ltd.	4165	N4
KOREA EPOXY LAMINATE	T2218	T2	Mykron Microelectronics Co., Ltd.	3721	N3
Kosma Filtration Technology Co., Ltd	T1301	T1	N Namics Corporation	T2231	T2
Kostek Systems, Inc.	T1232	T1	Nanjing Carry Foison Hard Materials Sci&Tech Co., Ltd.	T2141	T2
KOTRA (Korea Trade-Investment Promotion Agency)	5219	N5	Nanjing Guosheng Electronics Co., Ltd	5151	N5
KSM Co., Ltd.	2213	N2	Nanjing Sanchao Advanced Materials Co., Ltd.	5000	N5
Kulicke & Soffa Industries Inc.	3411	N3	Nanjing Taizhi Automation Technology Co., Ltd	5806	N5
Kun Shan CEMA Technology Corporation Ltd	5384	N5	Nanmat Technology Co., Ltd.	5808	N5
Kunshan Shieyu Valve Co., Ltd.	7175	E7	NanoVis Electronics Technologies (China) Limited	4651	N4
Kunshan You Fu Precision Machine Co., Ltd	3154	N3	Napson Corporation	1425	N1
Kunshan Zhimao Technology Equipment Co., Ltd.	3757	N3	Narasaki Trade (Shanghai) Co., Ltd	T2144	T2
Kurt Lesker (Shanghai) Trading Company	3235	N3	National Instruments	1618	N1
Kyungwon Tech Co., Ltd.	5783	N5	National Silicon Industry Group	5651	N5
Lapmaster Wolters GmbH	2687	N2	New Best Wire Industrial Co., Ltd.	2207	N2
Lasertec China Co., Ltd	5547	N5	New Fast Technology Co., Ltd.	7211	E7
Laserwort Ltd.	3243	N3	New Power Plasma Co., Ltd.	T2208	T2
LB Semicon	5314	N5	Newport Wafer Fab	T2154	T2
Leeno Industrial Inc.	5101	N5	Next Test Solution(NTS)	7115	E7
Legend Electronic Tech Co., Ltd	3241	N3	Nextool Technology Co.,Ltd	T2143	T2
Legend Trades (Shanghai) Corp.	T2248	T2	Niche-Tech Kaiser (ShanTou) Limited	5800	N5
Levitach B.V.	2659	N2	NIKON CORPORATION	3425-2	N3
LG Chem	5611	N5	Nikon Precision Shanghai Co., Ltd.	3425-3	N3
Lianyungang Donghai Hongwei Quartz Products Co., Ltd.	4239	N4	Ningbo Allsemi Microelectronics Equipment Co., Ltd	4117	N4
Linde LienHwa	T1401	T1	Ningbo Baosi Energy Equipment Co., Ltd	T2202	T2
Linggas (Tianjin), Limited.	1557	N1	Nippon Pulse Motor Trading (Taiwan) Co., Ltd.	3334	N3
Linkgenesis Co., Ltd.	7114	E7	NISHIMURA CHEMITECH CO.,LTD	T2373	T2
Lintec Advanced Technologies (Shanghai) Inc.	3459	N3	Nissan Chemical Corporation	2531	N2
Linx Consulting Inc	4339	N4	NISSEI CORPORATION	7705	E7
LK ENGINEERING CO., LTD.	5225	N5	NISSIN ALLIS ION EQUIPMENT (SHANGHAI) CO., LTD	2519	N2
Logitech Ltd.	4164	N4	Nordson Advanced Technology	3671	N3
Longhill Industries (Shanghai) Ltd	4206	N4	Nordson Advanced Technology	3637	N3
Loranger International Corporation	3609-2	N3	Nova Measuring Instruments Ltd.	4651	N4
LPE (Shanghai) International Trading Co., Ltd.	1521	N1	Novtec Technology	T2111	T2
LPKF Laser & Electronics AG	2683	N2	Nowes Technology Corporation Limited	1655	N1
Luoyang Liming Daesung Fluorine Chemical Co., Ltd	7543	E7	NSK (China) Investment Co., Ltd.	7509	E7
Luva System Inc.	T2310	T2	Ntek Litho	T2154	T2
M Mabuchi Spectra & Technology (Suzhou) Trading Inc.	7643	E7	NTS (Suzhou) Co., Ltd.	T1201	T1
Macquarie Equipment Trading	2378	N2	NTS Group B.V.	2758	N2
MacroTest Semiconductor, Inc.	7149	E7	NuFlare Technology, Inc.	1703	N1
Malvern Panalytical	T2151	T2	O OKins Electronics	5485	N5
Marketch International Corp.	3123	N3	OKY	1713	N1
Marketch International Corp.	3134	N3	Olympus (China) Co., Ltd	2527	N2
Marposs (Shanghai) Trading Ltd	T1110	T1	Organo Corporation	7230	E7
Maruyama Manufacturing Corporation	T2101	T2	Orient Service Corp.	3113	N3
Materion Corporation	4255	N4	Oxford Instruments	1635	N1
Matfron (Shanghai) Semiconductor Technology Co., Ltd	3589	N3	PacTech-Packaging Technologies GmbH	2471	N2
Maxone Semiconductor(Suzhou)Co.,Ltd	7252	E7	Pall (China) Co., Ltd.	4345	N4
MCL Electronic Materials, Ltd.	4677	N4	Panasonic Industrial Devices Materials (Shanghai)	7551	E7
MCRT Micro CleanRoom Technology GmbH	2670	N2	Co., Ltd		
MeetFuture China Co., Ltd	5543	N5	Park Systems Corp.	7330	E7
MEIDEN	T2328	T2	Parker Hannifin Motion & Control (Shanghai) Co., Ltd.	1721	N1
MEMPro Corp	5184	N5	Particle Measuring Systems, Inc.	5135	N5
memsstar Limited	5127	N5	PASS Ltd	2679	N2
MESOSCOPE TECHNOLOGY Co., Ltd.	2112	N2	PCEM Corporation	4140	N4
Meyer Burger (Germany) GmbH	2671	N2	PDMC	5743	N5
MI Global Technology (Beijing) Co., Ltd.	T1331	T1	PECO Precision Engineering(Suzhou) Co., Ltd	T2221	T2
MI Co Co., Ltd.	5289	N5	PEER Group Inc.	7139	E7
Micro-Mechanics (Su Zhou)	3763	N3	PEMTRON CORPORATION	T2105	T2
Microtronics Japan Co., Ltd	4707	N4	Pentamaster Equipment Manufacturing Sdn Bhd.	3186	N3
Micro-Power (H.K.) Semiconductor Ltd.	7735	E7	PerkinElmer Management (Shanghai) Co., Ltd	T2210	T2
Micro-Power Scientific (H.K.) Co. Ltd.	3183	N3	Pfeiffer Vacuum (Shanghai) Co., Ltd	2601	N2
MIEUX PTE LTD	T1329	T1	PFK Co., Ltd.	1519	N1
Milara Inc.	5431	N5	PhiChem Materials	4617	N4
Millennium Microtech (Shanghai) Co., Ltd	5623	N5	Photon Control Inc.	7615	E7
Miragas Co., Ltd.	T1207	T1	Pibond Oy	1737	N1
Mirap Pte. Ltd.	3717	N3	Picosun Oy	2241	N2
MIT Limited	4175	N4	Pinason (Shanghai) Co., Ltd.	2267	N2
Mitsubishi Electric Automation (China) Ltd.	T2247	T2	PNC Process Systems Co.,Ltd.	4245	N4
MK Trading (Shanghai) Co.,Ltd	T1117	T1	PowerTech Co., Ltd.	4459	N4
MKP Co., Ltd.	5213	N5	Precision Polymer Engineering Ltd.	3138	N3
MONOCRYSTAL	2263	N2	Precision Surfacing Solutions GmbH & Co.KG	2687	N2
MooreElite Technology Co., Ltd	T2129	T2	Premtek International Inc.	3645	N3
M-O-T Mikro und Oberflächentechnik GmbH	2481	N2	Proaut Technology GmbH	2575	N2
Motic China Group Co., Ltd.	T2331	T2	ProbeLeader Co., Ltd	4155	N4
MPI Corporation	3151	N3	PROBING GROUP	4441	N4
Msscrops (Nanjing) Co., Ltd	5759	N5	Prominent Trading (Dalian) Co., Ltd	5717	N5
MUEGGE GmbH	2671	N2	ProTec Carrier Systems GmbH	2573	N2

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PROTEC CO., LTD.	4637	N4	SEMES Co., Ltd.	4481	N4
PSK Inc.	7119	E7	SemiGlory Electronics (Chongqing) Co., Ltd	T1123	T1
PTW Asia Pte Ltd	2647	N2	Semilab Trade (Shanghai) Co., Ltd	3375	N3
Puhui Machinery Science And Technology Co., Ltd	4324	N4	Semiplastic High Purity Material (Kunshan) Co., Ltd	2113	N2
Pulse-tech (Hongkong) Technology Limited	T2340	T2	Semishare International Limited	7711	E7
Puritic Shanghai Corporation	3775	N3	Semisysco Co., Ltd.	5223	N5
PVA Crystal Growing Systems GmbH	2780	N2	Sempro Technologies b.v.	2651	N2
Q Q.D. HDTECH Micro electronics Co., Ltd.	4123	N4	SEMSYSCO GmbH	1712	N1
QES (Singapore) Pte Ltd	2738	N2	Sen Huan Electrical Technology Co., Ltd	2642	N2
Qingdao Fuso Refining & Processing Co., Ltd	7733	E7	Senju Metal (Shanghai) Co., Ltd.	2425	N2
Qingdao Huaqi Technology Co., Ltd.	4008	N4	Sensata Technologies (Changzhou) Co., Ltd	T1309	T1
Qingdao Share Microelectronics Co., Ltd	4213	N4	SENTECH Instruments GmbH	2131	N2
Qingdao Sunred Electronic Equipment Co., Ltd.	4309	N4	sentronics metrology GmbH	2680	N2
Qingdao Yuhao Microelectronics Equipment Co., Ltd.	4104	N4	Sesto Robotics Pte Ltd	2641	N2
Qinghai Huanghe Hydroponer Development Co., Ltd	7623	E7	SET Corporation S.A.	2481	N2
New Energy Branch			SETS	1535	N1
Quality Assurance Management Asia(Shanghai) Co., Ltd.	3176	N3	SGL Carbon Far East Ltd. Shanghai	7677	E7
Qualmax Testech, Inc.	5689	N5	Shandong Gaotang Jiesing Semiconductor Technology Co., Ltd	4127	N4
Quantum Global Technologies, LLC	3340	N3	Shandong Keda Dingxin Electronic Technology Co.,Ltd	4189	N4
Quarld-Quartz World	4763	N4	Shandong Weiji Carbon-Tech Co., Ltd	T2180	T2
Quest Technology (Shanghai) Co., Ltd.	5477	N5	Shanghai Advanced Engineering Technology, Inc.	2338	N2
Qwestar China Ltd.	3119	N3	Shanghai AfaPa Vacuum Equipment Co.,Ltd	4101	N4
Quick Gem Optoelectronic S&T Co.,Ltd	2127	N2	Shanghai ANT Piping Systems Co., Ltd	4808	N4
R Raenin Materials Co., Ltd	2662	N2	Shanghai ANT Piping Systems Co., Ltd	2822	N2
Raith China Co.,Ltd	2685	N2	Shanghai AREX Electronics Co., Ltd	T2121	T2
RAYMOND & CO	T2242	T2	Shanghai Bestity Semiconductor Technology Co., Ltd	4143	N4
RayZher Industrial Co., Ltd	T1211	T1	Shanghai Brother Microelectronics Technology Co., Ltd.	2319	N2
Regentek (Shanghai) Ltd.	T2309	T2	Shanghai CaiWin Electronics Co., Ltd	T2351	T2
Reid-Ashman Manufacturing, Inc.	T1134	T1	Shanghai Chiptube Semiconductor Material Co., Ltd	T2326	T2
RENA Technologies GmbH	2675	N2	Shanghai Companion Precision Ceramics Co., Ltd.	5161	N5
Reticle Labs LLC	T2178	T2	Shanghai Dongxu Electronic Technology Co., Ltd	4154	N4
Revasum	T2317	T2	SHANGHAI DUKE ELECTRONICS CO., LTD	2147	N2
REZONTECH Co., Ltd.	T1335	T1	Shanghai Ebara Precision Machinery Co., Ltd.	3225	N3
RF Global Solutions Ltd.	T2154	T2	Shanghai Etch Etchtronical Co., Ltd	T1114	T1
RIKEN KEIKI Co., Ltd.	7272	E7	Shanghai Fairfield Electronic Technology Co., Ltd	2163	N2
Riken Technos Corp.	T2265	T2	Shanghai FZ Technology Co., Ltd	2710	N2
RION CO., LTD.	4171	N4	Shanghai Gentech Co., Ltd.	4361	N4
RKC INSTRUMENT INC.	2122	N2	Shanghai Haile Electronics Tech Co., Ltd	3180	N3
Roehling Engineering Plastics (Suzhou) Co., Ltd	T1125	T1	Shanghai Hanhong Precision Machinery Co., Ltd	1431	N1
Rokko Electronics Co., Ltd.	2606	N2	Shanghai Haogu Industrial Co., Ltd	5816	N5
ROKKO Systems Pte Ltd	3779	N3	Shanghai Heli Industrial Gas Co.,Ltd	5775	N5
Rorze Technology, Inc.	4271	N4	Shanghai Hongchuan Electronics Co., Ltd.	2104	N2
Rotarex Star	7110	E7	Shanghai Hongjun Industrial Co., Ltd	T2332	T2
RPS CO., LTD.	2158	N2	Shanghai Hongtai Environment Technology Co., Ltd	T2277	T2
Rudolph Technologies, Inc.	4559	N4	Shanghai Huahong Grace Semiconductor Manufacturing Corporation	5447-1	N5
Ruter Elastomer Co., Ltd	3208	N3	Shanghai Huasong Enterprise	2613	N2
S S&S TECH CORPORATION	T2235	T2	Shanghai Icwiser communication Technology Co.,Ltd	7336	E7
S.Y. Technology Engineering & Construction Co., Ltd	1757	N1	Shanghai Integrated Circuit Industry Association	T2134	T2
Sae Han Micro Tech Co., Ltd.	2715	N2	Shanghai Jerine Electromechanical Technology Co.,Ltd	3118	N3
Saesol Diamond Ind. Co., Ltd.	7000	E7	Shanghai Jet Plasma Co.,Ltd	2783	N2
Saint-Gobain	T2342	T2	Shanghai JinFu Electromechanical Technology Co., Ltd	7255	E7
Saint-Gobain Performance Plastics (Shanghai) Co., Ltd.	1743	N1	Shanghai JUYA Technology Co.,Ltd	2513	N2
Salus Engineering International	4384	N4	Shanghai Juyue Detection Technology Co.,Ltd	7131	E7
Samco Inc.	2539	N2	Shanghai King Virtue Electron Co., Ltd	3425-1	N3
Samil Tech Co., LTD.	2123	N2	Shanghai Leading Semiconductor Technology Development Co., Ltd.	2244	N2
Sangyo Times Co., Ltd.	5707	N5	Shanghai Lieth Precision Equipment Co., Ltd	5577	N5
Sanyo Denki Shanghai Co., Ltd	7355	E7	Shanghai Lush Mount Int'l Trade Ltd.	4339	N4
Saratoga Technology International	2014	N2	Shanghai Micro Electronics Equipment (Group) Co., Ltd.	3651	N3
SAS Semiconductor Technology (Shanghai) Co., Ltd	5139	N5	Shanghai Miya Technology Co., Ltd.	7608	E7
Saultech Technology Co., Ltd.	5371	N5	Shanghai MOJUNE Electronic Technology Co., Ltd	2611	N2
SAWATEC AG	2785	N2	Shanghai Morn Technology Co., Ltd	T2336	T2
SCH Electronics (Shanghai) Co., LTD.	3675	N3	Shanghai Nissin Machine Tool Co.,Ltd	1631	N1
Schenker AG	2581	N2	Shanghai O-Best Electronic Technology Co., Ltd.	5489	N5
Schmidt International Trading (Shanghai) Co., Ltd.	4251	N4	Shanghai Pillar Trading Co., Ltd	2707	N2
Schneeberger (Shanghai) Co., Ltd.	2583	N2	SHANGHAI PLUSCO TECH CO., LTD	7268	E7
Schneider Automation Controls & Systems (Shanghai) Company, Limited	5733	N5	Shanghai Precision Measurement Semiconductor Technology, Inc	5647	N5
SCI Automation Pte Ltd.	2639	N2	Shanghai Pujiang Specialty Gases Co., Ltd	2235	N2
scia Systems GmbH	5127	N5	Shanghai Quanghai Industrial Corporation	5167	N5
Scientech Corporation	3319	N3	Shanghai Ruicun Purification Engineering Co., Ltd	3116	N3
SE Technologies Corp.	3383	N3	Shanghai Shengjian Environment Technology Co, Ltd	7363	E7
Seal Tech Welded Bellows (Liaoning) Co., Ltd.	2275	N2	Shanghai Shenma Fluid Equipment Co., Ltd.	2800	N2
SEAL Co.,Ltd	4184	N4	Shanghai Simpure Gas Technology Co., Ltd.	4826	N4
SEEDRI Beijing	7607	E7			
Seiwa Optical (Shanghai) Co.,Ltd.	4703	N4			
Sekisui Chemical Co., Ltd	7714	E7			
Selling-Ware Co., Ltd.	3627	N3			

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Shanghai Sinyang Semiconductor Materials Co., Ltd	5241	N5	SKY Technology Development Co.,Ltd Chinese Academy of Sciences	3305	N3
Shanghai SNA Equipment Technology Co., Ltd	T2126	T2	Skyverse Limited	5461	N5
Shanghai STN Electrical & Machinery Co., Ltd	7313	E7	SMC (China) Co., Ltd	2101	N2
Shanghai sunden technology Corporation	T2339	T2	SMG Co., Ltd.	5205	N5
Shanghai Supex Industrial Supply Co., Ltd.	7116	E7	SMT Corporation	T2379	T2
Shanghai Vastity Electronics Technology Co.,Ltd.	4645	N4	SOLARIUS DEVELOPMENT INC.	7628	E7
Shanghai Win-Win Welding Equipment Co., Ltd	7176	E7	Solecon Laboratories	T1105	T1
Shanghai Xuyi Electronic Technologies Co., Ltd.	2108	N2	Solvay (Shanghai) Co., Ltd.	T2238	T2
Shanghai Yikang Chemicals & Industries Co. Ltd	5576	N5	Song Jing Technology Co., Ltd.	T1411	T1
Shanghai Yishi Trading Co., Ltd	7666	E7	Specho Technology Co., Limited	T2205	T2
Shanghai Yishi Trading Co., Ltd	7667	E7	Spectrum Materials Corporation Limited	5154	N5
Shanghai Yodogawa Trading Co.,Ltd	7639	E7	Speedfam Mechtronics (Nanjing) Ltd	2271	N2
Shanghai ZAP Technology Company Limited	2239	N2	SPEKTRA Schwingungstechnik und Akustik GmbH	2778	N2
Shanghai Zhenhai Instrument Co.,Ltd	T2305	T2	Spiro Corporation	3451	N3
Shanghai Zhonghui Electronics Technology Co., Ltd	2804	N2	SPMC (Changzhou) Co., Ltd.(Semiconductor Precision Machinery)	3741	N3
Shaoxing Hongbang Electronics Technology Co., Ltd	4489	N4	Sprint Precision Technologies Co., Ltd	5761	N5
Shenkeda Semiconductor Co., Ltd	7259	E7	SPT- Small Precision Tools Co., Ltd.	3753	N3
Shenyang Fortune Precision Equipment Co., Ltd.	3301	N3	SPTS Technologies (An Orbotech Company)	3243	N3
Shenyang Hanway Science&Technology Co., Ltd	2254	N2	SSP Inc.	5207	N5
Shenyang Heyan Technology Co.,Ltd	2387	N2	ST Corporation	5221	N5
Shenyang Piotec Technology Co., LTD	T1208	T1	Standard Technology Corporation	3131	N3
Shenyang Piotech Co., Ltd.	3211	N3	Stella Technology Co., Ltd.	3487	N3
Shenyang SIASUN Robot & Automation Co., Ltd.	3309	N3	Stratus Vision GmbH	2679	N2
Shenyang Silicon Technology Co., Ltd.	3313	N3	Sumika Electronic Materials (Shanghai) Corporation	2183	N2
Shenzhen Allmerit Technology Co., Ltd.	2171	N2	Sumika Electronic Materials(Changzhou)Co.,Ltd	2183	N2
Shenzhen Bindebao Electronic Technology Co., Ltd	3142	N3	Sumika Electronic Materials(Xian)Co.,Ltd	2183	N2
Shenzhen Chi Yang Technology Co., Ltd	T2209	T2	Sumitomo (SHI) Cryogenics Shanghai., Ltd.	7135	E7
Shenzhen Dejiabao Electronics Co., Ltd	1720	N1	Sumitomo Chemical Company, Ltd.	2183	N2
Shenzhen Fountyl New Materials Technology Co., Ltd	T2363	T2	Sumitomo Heavy Industries, Ltd.	7287	E7
Shenzhen Good-Machine Automatic Equipment Co., Ltd	T2161	T2	Sumitomo Heavy Industries, Ltd.	T1339	T1
Shenzhen HanHwa Semiconductor Technology Co., Ltd	T1425	T1	Sumitomo Mitsui Finance and Leasing Co. Ltd.	4525	N4
Shenzhen Hans Semi Equipment Technology Co., Ltd	T2138	T2	Sunray New Energy Co., Ltd.	4401	N4
Shenzhen Hiner Advanced Materials Technology Co.,Ltd.	5364	N5	Suntech Co., Ltd	4637	N4
Shenzhen Huahang Aluminum Material Co., Ltd.	T2302	T2	Suntific Materials (Weifang), Ltd	2119	N2
Shenzhen Ingenuity Mfrs Technology Co., Ltd	T2237	T2	Sunto Semiconductor Technology Shanghai Co., Ltd.	5810	N5
Shenzhen Inte Laser Technology Co., Ltd	2654	N2	Super Equipment Shanghai Inc	T1131	T1
SHENZHEN JINNUODA TEFLON ELECTROTHERMAL TECHNOLOGY Co., Ltd	4138	N4	SurplusGLOBAL, Inc.	4351	N4
Shenzhen June's Automation Co., Ltd.	3683	N3	SUSS MicroTec (Shanghai) Co., Ltd.	1531	N1
Shenzhen Just Photoelectric Equipment Co., Ltd	4113	N4	Suzhou Betpak New Material Technology Co., Ltd	7216	E7
Shenzhen Laun Technology Co., Ltd	1507	N1	Suzhou Bolet Quartz Co., Ltd	T2367	T2
Shenzhen Leaderwe Intelligent Co., Ltd	T1333	T1	Suzhou Chengli Electronic Material Co., Ltd	3112	N3
Shenzhen Liande Automation Equipment Co., Ltd	T2253	T2	Suzhou Crystal Clear Chemical Co., Ltd.	5251	N5
Shenzhen MicroASM Semiconductor Technology Co.,Ltd	7754	E7	Suzhou CSE Semiconductor Equipment Technology Co., Ltd	5584	N5
Shenzhen MicroASM Semiconductor Technology Co.,Ltd	7174	E7	Suzhou HanHua Semiconductor Co., Ltd	T1135	T1
Shenzhen Pingchen Semiconductor Technology Co. Ltd	4147	N4	Suzhou HRT Electronic Equipment Technology Co., Ltd	4131	N4
Shenzhen Pure Water No.1 Industry Development Co., Ltd.	T2177	T2	Suzhou HYC Technology Co., Ltd	T2214	T2
Shenzhen Rongda Photosensitive Science & Technology Co., Ltd	7136	E7	Suzhou Industrial Park A-Tech Technology Co., Ltd.	2535	N2
Shenzhen Secon Technical Industry Co., Ltd	3826	N3	Suzhou IV Technologies Co., Ltd	7310	E7
Shenzhen Selen Science & Technology Co., Ltd.	2201	N2	Suzhou Jieruisi Automatic Equipment Co., Ltd	T2243	T2
Shenzhen Sidea Semiconductor Equipment Co., Ltd.	4671	N4	Suzhou Jingya Clean Technology Co., Ltd.	2523	N2
Shenzhen SM Precise Mould Co., Ltd	7014	E7	Suzhou Jinhong Gas Co., Ltd	1551	N1
Shenzhen Tensun Industrial Equipments Co.,Ltd.	5275	N5	Suzhou JYD Industrial Co.,Ltd	4217	N4
SHENZHEN XINYICHANG AUTOMATIC EQUIPMENT CO., LTD	7157	E7	Suzhou MEMStools Semiconductor Technology Co.,Ltd	2733	N2
Shenzhen Yaotong Technology Co., Ltd.	3800	N3	Suzhou Mica Technology Co., Ltd.	3713	N3
Shenzhen Yehao Semiconductor Equipment Co., Ltd.	7237	E7	Suzhou New Star Environment Technology Corp.	7614	E7
Shibaura Mechatronics Corp.	7367	E7	SuZhou Pertech Technol Inc	1601	N1
Shibuya Corporation	7629	E7	Suzhou Sail Science & Technology Co., Ltd.	2283	N2
Shin-Etsu Polymer Hong Kong Co., Ltd	7206	E7	Suzhou SICEAT Nanotech Co., Ltd.	4108	N4
Shinkawa (Shanghai) Co., Ltd.	3163	N3	Suzhou Silicon Test System Co., Ltd	7539	E7
Sichuan Injet Electric Co., LTD.	4014	N4	Suzhou SLD Electronic Co., Ltd	2351	N2
Sichuan RMS Business & Trade Co., Ltd	4687	N4	Suzhou Superlight Micro Electronics Co., Ltd.	4289	N4
SIERRA Instruments (Shanghai) Ltd.	T2170	T2	Suzhou Superlight Micro Electronics Co., Ltd.	3810	N3
Sigold Optics, Inc.	4571-2	N4	Suzhou Suyuan Advantec Machinery Co., Ltd	7239	E7
Silpac International Limited	4389	N4	Suzhou TA&A Ultra Clean Technology Co.,Ltd.	2231	N2
SINFONIA TECHNOLOGY CO., LTD.	2622	N2	Suzhou Tusen Laser Co., Ltd	1715	N1
Singulus Technologies AG	2774	N2	Suzhou Xinshangsi Automatic Equipment Co., Ltd	T2361	T2
Sinochem Lantian Co., Ltd.	5185	N5	SVCS Process Innovation s.r.o.	2419	N2
SK Materials Co., Ltd.	5385	N5	Swagelok (Shanghai) Fluid Systems Technologies Co., Ltd	3467	N3
SKC Solmics Co., Ltd.	5131	N5	Synergie Cad GROUP	7715	E7
Skwntex International(Shanghai) Corp.	5587	N5	Systematic Technology (Shanghai) Co., Ltd.	3733	N3
			SZSI-TECH	T2366	T2
			T+C Machine Trading Pte Ltd Shanghai	T2206	T2

SEMICON China 2019 Exhibitors List

Company	Booth	Hall	Company	Booth	Hall
Tachia Yung Ho Machine Industry Co., Ltd	2704	N2	United Precision Technologies Co.,Ltd.	7567	E7
Tadu Co., Ltd	T2137	T2	UniTemp GmbH	2776	N2
Taihe Gases (Jingzhou) Limited	7354	E7	UniTest Inc.	5117	N5
Taiji Semiconductor (Suzhou) Co., Ltd	5643	N5	UnitySC	7671	E7
TAISEI GIKEN CO.,LTD.	7215	E7	U-Precision Tech Co., Ltd.	4467	N4
Taiwan Carrier Tape Enterprise co., Ltd.	T1321	T1	Ushio Shanghai ,Inc	1641	N1
Taiwan Kong King, Co., Ltd.	4265	N4	UVIR CO., LIMITED	T2213	T2
TAIYO HOLDINGS CO.,LTD.	5757	N5	Valqua (Shanghai) Trading Co., Ltd.	7163	E7
Taiyo Nippon Sanso Trading (Shanghai) Co., Ltd	7681	E7	Value Engineering, Ltd.	2623	N2
Tanaka Kikinzoku International (Shanghai) Co., Ltd.	3257	N3	Veeco Instruments (Shanghai) Co., Ltd.	2605	N2
TankeBlue Semiconductor Co., Ltd.	1401	N1	VERSUM MATERIALS (SHANGHAI) CO., LTD	5343	N5
TAZMO Appreca Electronics (Shanghai) Inc.	7401	E7	Vertiv Tech Company Ltd.	5753	N5
TDG Machinery Technology Co.,Ltd	4315	N4	Victrex PLC	T2230	T2
TDK Corporation	4158	N4	Vicino Technology Co., Ltd	T2335	T2
Techneglas, LLC.	5481	N5	Vistec Electron Beam GmbH	2577	N2
Technic (China-HK) Limited	5222	N5	Vital Materials Co., Limited	T1431	T1
Technical & Try Co., Ltd.	7649	E7	ViTrox Technologies Sdn. Bhd.	4667	N4
Technoprobe	T1426	T1	Wafer Works Corporation	7477	E7
Technworks/NMI	T2154	T2	Warwick Instruments (Zhu Hai) Co., Ltd	7612	E7
TECNISCO (Suzhou) Co., Ltd	7533	E7	Watlow	T1101	T1
Teesing Industrial Systems (Beijing) Co., Ltd.	T2139	T2	Wenyl Trinity Technology Co., Ltd	4631	N4
TEKTRONIX	5709	N5	Wenzhou Guanbo Instrument Valve Co., Ltd	2555	N2
Telemark(Shanghai) Co., Ltd	1517	N1	Wenzhou Zhibo Mechanical Technology Co.,Ltd	7134	E7
Teltec Semiconductor Pacific Limited	3363	N3	WESI Technology Limited	5127	N5
Teltec Semiconductor Pacific Limited	3351	N3	Whole Link International	3609-1	N3
Tempress Systems B.V.	2756	N2	Wholtech System Hitech (Shanghai) Co.,Ltd	2363	N2
Teradyne, Inc.	3419	N3	WIKA International Trading (Shanghai) Co., Ltd.	2681	N2
Tesec Corporation	3358	N3	Win Win Precision Technology Co., Ltd.	4134	N4
Test Tooling Solutions (M) Sdn. Bhd.	3109	N3	Wing Loong Equipment (Da Lian) Co., Ltd	4753	N4
Tetron Technologies Ltd.	T2154	T2	Wingzhen Technology (Shenzhen) Co., Ltd.	7800	E7
TFE Inc.	7563	E7	WINSUN (Shanghai) Electronic Co., Ltd	7248	E7
The Fourth Construction Co., Ltd. of China Electronics System Engineering	5507	N5	Wintech-Nano (Suzhou) Co., Ltd.	3184	N3
Thermo Fisher Scientific	5619	N5	Wintest Corp.	T1237	T1
Thin Film Equipment srl	2682	N2	WinWay Technology Co., Ltd.	2753	N2
Tianjin Zhonghuan Semiconductor Co., Ltd.	5451	N5	WinWin Electronic Technology International Limited	3160	N3
Tianjing EMAGING Technology co, ltd	T2307	T2	Wire Technology Co., Ltd.	4571-3	N4
TKC Co., Ltd.	7481	E7	Wonder Light Industry Mach&Elec Products (Zhongshan) Co., Ltd	T2306	T2
TMH Inc.	7581	E7	Wonik IPS Co., Ltd.	3139	N3
TMS Technology	1623	N1	Wonik Materials Co., Ltd.	4581	N4
TOCALO&HANTAI (KUN SHAN) CO., LTD	7106	E7	Wonik QnC	2739	N2
Toflo Corporation Shanghai Representative Office	4122	N4	Wooam Super Polymer Co., Ltd.	3804	N3
Tokai Carbon (Dalian) Co., Ltd	7501-2	E7	Woojin I&S Co., Ltd.	2722	N2
Tokkyokiki Corporation	T2369	T2	World Star Electronic Material Co., LTD TIANJIN	2120	N2
TOKYO KEISO CO., LTD.	3689	N3	WuHan MEMS Card Micro Electrical Co., Ltd	T2125	T2
TOKYO SEIMITSU CO., LTD.	4451	N4	Wuxi Jerome Precision Mechanics Co., Ltd.	3785	N3
Tokyo Electron Limited	5419	N5	Wuxi Quanyi Technology Co.,Ltd.	T2330	T2
TongFu Microelectronics Co.,Ltd.	5525	N5	Wuxi Radar Electronic Technology Co., Ltd.	4816	N4
Tonglin Poonsan Sanjia Microtech Co., Ltd.	2151	N2	Wuxi Sky Chip Interconnection Technology Co., Ltd.	5739	N5
TooTec Co., Ltd.	5201	N5	Wuxi Wewin Electronic Equipment Co., Ltd.	4822	N4
Topco Scientific (Shanghai) Co., Ltd.	7201	E7	WUXI WORLD TRADING CO., LTD	4204	N4
Toray Engineering Co., Ltd.	4713	N4	Wuxi Xudian Technology Co., Ltd	T2377	T2
Toray Industries Inc.	4713	N4	XH Industrial Co., Limited.	2154	N2
Toray Research Center, Inc.	4713	N4	Xiamen Baoshili Dustless Technology Co., Ltd.	2164	N2
Towa Corporation	7443	E7	Xiamen ChaiPing Diamond Industrial Co., Ltd.	2134	N2
Toyo Advanced Technologies Co., Ltd.	2176	N2	Xiamen Twinwin Automation Technology Co., Ltd	4105	N4
Toyobishi Corporation	3356	N3	Xi'an Running Superhard Tools Technology Co., Ltd.	2759	N2
Toyoko Gase Equipments (Shanghai) Co., Ltd.	3816	N3	Xycarb Ceramics BV, Taiwan Branch	2339	N2
Trebor International, a Unit of IDEX Corporation	3828	N3	Yamaichi Electronics Hong Kong Ltd	3104	N3
Trelleborg Sealing Solutions (China) Co., Ltd.	T2234	T2	Yancheng Giga Diamond Materials Corporation	T2261	T2
Trinity Co., Ltd	T1313	T1	Yangzhou Sipuer Technology Company	4209	N4
Trustec Co., Ltd.	5371	N5	Yantai Yesdo Electronic Materials Co., Ltd	5265	N5
TRY Precision Co., Ltd.	3157	N3	Yaskawa Tsusho (Shanghai) Co., Ltd	T1217	T1
Trymax Semiconductor Equipment B.V.	2661	N2	Ye Siang Enterprise Co. Ltd	2287	N2
TS Tech (Changzhou) Co., Ltd	T2365	T2	Yole Developpement	T1435	T1
TSE Co., Ltd.	4587	N4	Yongoo Technology Co.,Ltd	5238	N5
TT Vision Technologies SDN BHD	T2321	T2	Youngin Equipment Solution Technology(YEST)	4112	N4
Turner Technology Co., Ltd.	7210	E7	YungTek Electronics Corp.	7816	E7
Turnon Co., Ltd	5661	N5	Yu Shyan System Technology Materials Co., Ltd.	7812	E7
TwinSolution Technology (Shanghai) Co.,Ltd	4689	N4	Yuhuan Clangsonic Ultrasonic Co., Ltd	7519	E7
Ueno Seiki Co., Ltd.	3263	N3	YUYU Lighting Co., Ltd.	7728	E7
Ultech Co., Ltd.	T1130	T1	Z&H Electronic Co.,Ltd	T1417	T1
Ultratorr Technologies, Inc	5164	N5	Zen Voce (Suzhou) Corporation	2409	N2
Umicore Thin Film Products	3703	N3	ZEUS	7301	E7
Uneo Inc.	1615	N1	Zhangjiagang Dayizhou Precision Filter Material Co., Ltd	7515	E7
UNILOK Corporation	7429	E7	Zhangjiagang Ultrasonic Electric Co.,Ltd.	7126	E7
UNISEM Co., Ltd	T1107	T1	Zhejiang Britech Co., LTD.	5177	N5

SEMICON China 2019 Exhibitors List

Company	Booth Hall	Company	Booth Hall
Zhejiang Cheer Mechanical & Electrical Technology Co., Ltd	T1140 T1	Zhejiang Shangneng Industrial Co., Ltd	T2252 T2
Zhejiang Chip Sunshine Equipment Technology Co., Ltd	T1106 T1	ZheJiang XIYT Electronics Materials Co. Ltd.	7219 E7
Zhejiang Fangdun Instrument valve Co., Ltd	T1424 T1	Zhejiang Yuanyao Valve Industry Co., Ltd	7150 E7
Zhejiang Jingsheng Mechanical & Electrical Co., Ltd.	4201 N4	Zhejiang Yunfeng New Material Technology Co., Ltd	1645 N1
Zhejiang Jingsheng Mechanical & Electrical Co., Ltd.	4312 N4	Zhengzhou Hongtuo Superabrasive Products Co., Ltd.	4517 N4
Zhejiang Kaisan Fluorochemical Co., Ltd.	5171 N5	Zhengzhou Research Institute for Abrasives & Grinding	2325 N2
Zhejiang Lante Optics Co., Ltd.	T1423 T1	Co., Ltd	
Zhejiang Mfab Technology Co., Ltd	5711 N5	ZHONGCHUANG ENG CO., LTD	3108 N3
Zhejiang Morita New Materials Co., Ltd	T2273 T2	Zillion Tek Co., Ltd	4812 N4
Zhejiang SemiEngine Technology Co., Ltd	5741 N5	ASML Netherlands B.V.	5671 N5

WFD Pavilion

Company	Booth Hall	Company	Booth Hall
Edwards Technologies Trading(Shanghai) Co., Ltd.	7480-1 E7	Shanghai Huali Microelectronics Corporation	7480-6 E7
ASML China	7480-2 E7	Shanghai Huahong Grace Semiconductor Manufacturing Corporation	7480-7 E7
KLA Corporation	7480-3 E7		
ASE Group	7480-4 E7	Hua Hong Semiconductor (Wuxi) Limited	7480-8 E7
Shanghai Huahong (Group) Co., Ltd.	7480-5 E7	Zhangjiagang High-Tech Industrial Development Zone	7480-9 E7

FPD China 2019 Exhibitors List

Company	Booth Hall	Company	Booth Hall
American Membrane (Nan Tong) Co., Ltd	1327 N1	Huang Yih Gear Industry Co., Ltd.	1231 N1
AnHui Hongshi Automation Equipment Co., Ltd	1361 N1	Hugle Electronics, Inc.	1487 N1
AP SYSTEMS CORPORATION	1271 N1	IMT Co., Ltd.	1354 N1
APP Co., Ltd	1358 N1	INFITECH	1259 N1
Asahi Sunac Corporation	1322 N1	Innodis Co., Ltd.	1265 N1
Asia IC Mic-Process, Inc.	1239 N1	INXA Technology & Design (Suzhou) Co., Ltd	1285 N1
ASUNG PLASTIC VALVE CO.,LTD	1175 N1	IST METZ GmbH	1775 N1
Atlas Copco (Shanghai) Trading Co., Ltd	1236 N1	Jesagi Hankook Ltd.	1189 N1
BBS Kinmei Co., Ltd.	1565 N1	Jiangsu Hantop Photo-Materials Co.,Ltd	1185 N1
Beijing Gmpower Tech Co., Ltd	1139 N1	Jing He Science Co.,Ltd.	1237 N1
Beijing KHL Technical Equipment Co. Ltd.	1304 N1	King Lai Hygienic Materials Co., Ltd.	1331 N1
Beijing Plastics Research Institute	1141 N1	Kinik Company	1247 N1
Boyue Instruments (Shanghai) Co., Ltd.	1674 N1	Korea Trade-Investment Promotion Agency(KOTRA)	1263 N1
BRUSH BANK	1350 N1	Kromax International (Shanghai) Corp.	1000 N1
Busch Vacuum (Shanghai) Co, Ltd.	1567 N1	KUM SUNG DIAMOND CO., LTD.	1364 N1
C Sun Mfg Ltd.	1201 N1	Kunshan VEL electronics Technology Co., Ltd.	1155 N1
C. ILLIES TRADING (SHANGHAI) CO., LTD.	1125 N1	Leybold (Tianjin) International Trade Co., Ltd	1104 N1
Cangzhou Sunheat Chemicals Co.,Ltd.	1308 N1	LiDa Optical And Electronic Co., Ltd	1205 N1
Canon Optical Industrial Equipment (Shanghai) Ltd	1319 N1	LINTEC Co., Ltd.	1223 N1
Cassion Technology Development Ltd	1800 N1	LMS Corporation	1261 N1
CHENG HUI Advanced Co., LTD.	1808 N1	M.Braun Inertgas Systems (Shanghai) Co., Ltd	1154 N1
Chongqing Tonghui Kefa Gas Co. LTD	1785 N1	MAGNEX CO., LTD.	1171 N1
CN1 Co., Ltd	1143 N1	Manz Taiwan Ltd.	1689 N1
CNT	1158 N1	MAT PLUS Co., Ltd	1571 N1
DAIHEN Corporation	1301 N1	Matrix Applied Technology Corporation	1338 N1
Dalian F.T.Z CREDIT Chemical Technology Development Co., Ltd.	1213 N1	Maxclean Technology (Wuxi) Co., Ltd	1176 N1
Durasonic	1253 N1	McScience Inc.	1269 N1
Edwards Technologies Trading (Shanghai) Co., Ltd.	1309 N1	Midas System Co.,Ltd	1362 N1
Electronic Materials Co., Ltd	1275 N1	New Energy Technology Co., Ltd	1211 N1
ENF Technology	1381 N1	NICHAS (Shanghai) Trading Co., Ltd.	1254 N1
Evest Corporation	1341 N1	Omat Sputtering Targets (Dong Guan) Co., Ltd	1365 N1
FLUONICS Co., Ltd	1284 N1	Osaka Vacuum, Ltd.	1138 N1
Foshan Shunde Topcod Industrial Co., Ltd	1664 N1	PLANSEE SE	1127 N1
FUJIAN ACETRON New Materials Co., Ltd	1008 N1	Pureach Tech (Beijing) Ltd.	1240 N1
Gallant Precision Machining Co., Ltd.	1345 N1	RADIATION TECHNOLOGY (Shanghai) CO.,LTD	1783 N1
Gentec (Shanghai) Corporation	1800 N1	SCREEN Semiconductor Solutions Co., Ltd.	1109 N1
Geowell Vacuum Co., Ltd	1209 N1	SEBA Inc.	1812 N1
GST CO., LTD.	1267 N1	Shanghai Glorysoft Co., Ltd.	1816 N1
H.C.Starck, Inc.	1281 N1	Shanghai Hanbell Precises Machinery Co., Ltd.	1151 N1
HACO RICHFUL TECHNICAL DEVELOPMENT CO., LIMITED	1184 N1	Shanghai Inova Technology Co., Ltd.	1134 N1
Hangzhou Greenda Electronic Materials Co., Ltd.	1131 N1	Shanghai Kaisite Steel Pipe Group Co., Ltd	1665 N1
HB TECHNOLOGY	1683 N1	Shanghai Liqiu Glass Co., Ltd	1114 N1
Heraeus Deutschland GmbH & Co. KG	1483 N1	Shanghai PROSRUN Technology Co., Ltd.	1118 N1
Highlight Tech (Shanghai) Corp	1159 N1	Shanghai Xiangzhuo Vacuum Hose Co., Ltd	1774 N1
Hightec Systems Corporation	1577 N1	Shenzhen CAPCHEM Technology Co., Ltd	1181 N1
Hua Laser Electro-Optics Co.,Ltd	1764 N1	Shenzhen CSL Vacuum Science and Technology., Ltd	1687 N1
		Shenzhen New Way Photomask Making Co., Ltd.	1219 N1
		Shuz Tung Machinery (Kunshan) Co., Ltd.	1243 N1

FPD China 2019 Exhibitors List

Company	Booth Hall	Company	Booth Hall
Simax Asia Pacific Limited	1222 N1	TSC Inc.	1387 N1
SNU Precision Co.,Ltd.	1366 N1	ULVAC (Shanghai) Trading Co. Ltd.	1101 N1
Solar Chemical Applied Materials Technology (Kunshan) Co.,Ltd	1227 N1	Unicom Technology Co., Ltd	1671 N1
Space Solutions Co., Ltd.	1251 N1	Unilam Co., Ltd.	1258 N1
Sun Yan Electronics	1828 N1	Utechzone Co., Ltd.	1342 N1
Sungdo Eng	1371 N1	V TEX Corporation	1144 N1
Sunic system	1255 N1	VAT Vacuum Valves (Shanghai) Co. Ltd	1465 N1
Suzhou Honbest Ultra Clean Technology Co., Ltd	1667 N1	Vero Veria Corporation	1820 N1
Suzhou U-air Environmental Technology Co., Ltd.	1575 N1	Vigor Gas Purification Technologies, Inc.	1142 N1
SVG TECH GROUP	1164 N1	Weihai Yuetai Precision Machinery co., LTD	1234 N1
Syccos Instruments Co.,Ltd.	1675 N1	Winifred International Technology (Shanghai) Ltd.	1145 N1
Ta Liang Technology Co., Ltd.	1677 N1	Woori Micron	1257 N1
Taichang Thintech Materials Co., Ltd	1135 N1	Wujiang Juji Microfibers Clean Textiles Co., Ltd	1262 N1
Taikyo Trade (Shanghai). Co., Ltd.	1355 N1	Xiamen Honglu Tungsten Molybdenum Industry Co., Ltd	1167 N1
Taiwan Electronic Equipment Industry Association	T1338 T1	Xi'an ShiXuan Metal Materials Co., Ltd.	1123 N1
TDG HOLDING CO.,LTD.	1119 N1	Xinxiang Baihe O.E Co., Ltd	1110 N1
Tem Trade (Shanghai) Co., Ltd	1786 N1	ZENIX Co., Ltd	1186 N1
TES Co., Ltd.	1583 N1	Zhangjiagang Parkson Package Material Co., Ltd	1763 N1
Thomas engineering.,Ltd	1351 N1	Zhejiang Micromagneticprecision Technology Co., Ltd	1260 N1

合作媒体



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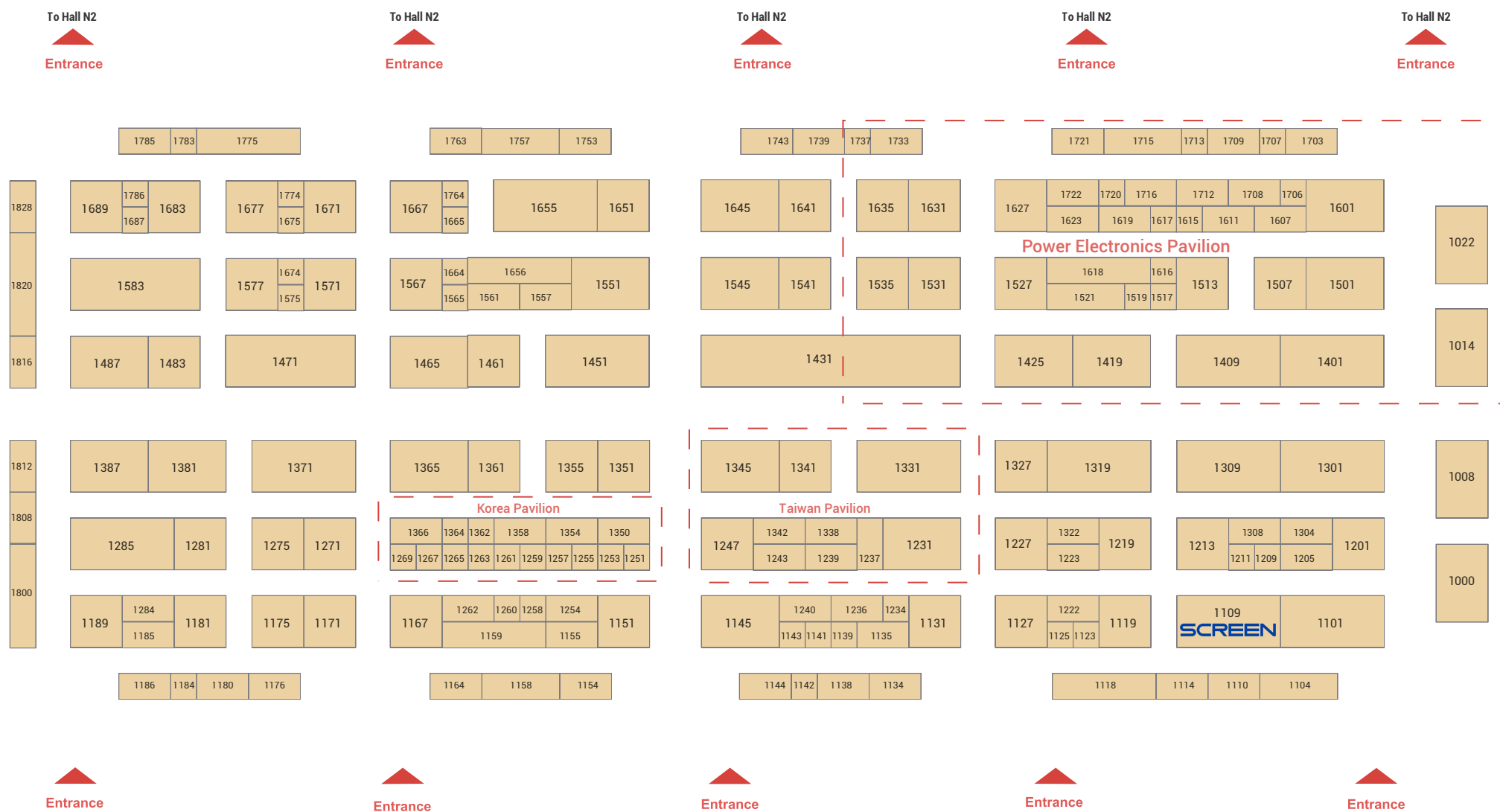
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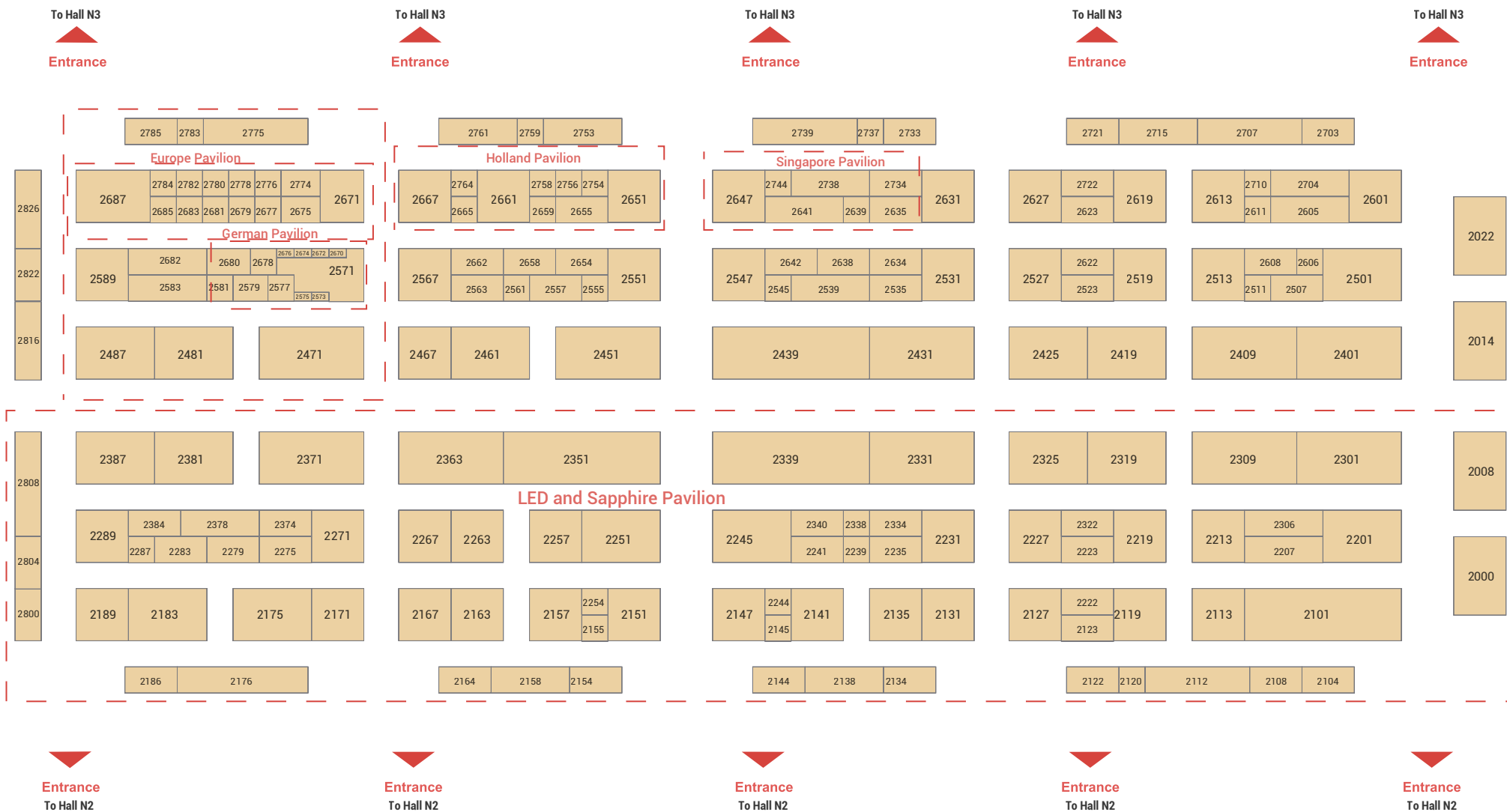
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業務聯絡人: 黃一瑋 手機: 86-18021613738

展馆平面图 HALL N1



展馆平面图 HALL N2



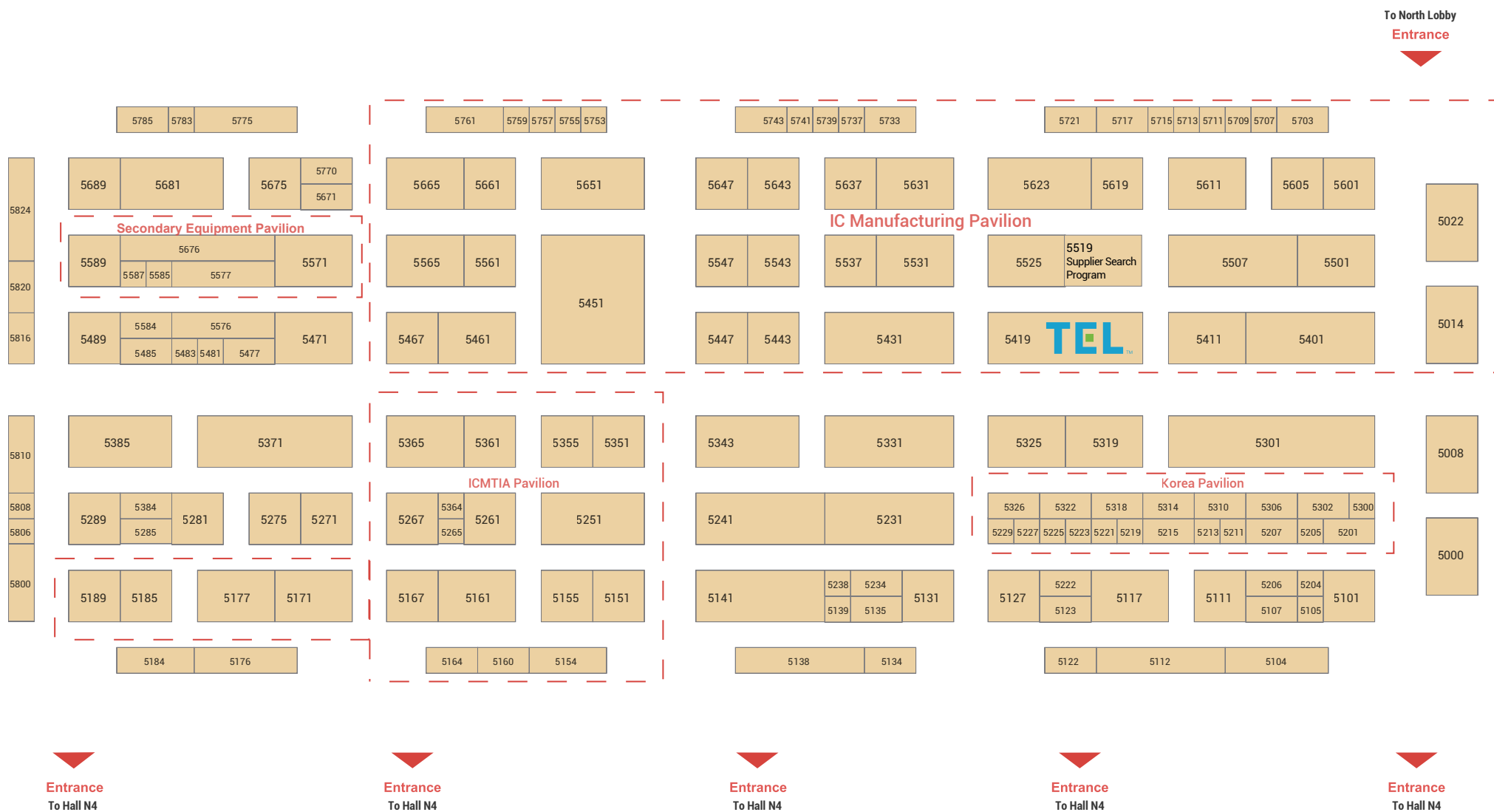
展馆平面图 HALL N3



展馆平面图 HALL N4



展馆平面图 HALL N5



展馆平面图 HALL E7



展馆平面图 HALL T1

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展馆平面图 HALL T2

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T2100 WFD Office

SEMI 中国英才计划

SEMI Workforce Development China



全球半导体和电子制造业在吸引、留住和培养人才方面正面临越来越多的挑战，巨大的人才缺口成为了制约产业发展的关键因素。

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中国国际半导体技术大会 (CSTIC) 2019

China Semiconductor Technology International Conference (CSTIC) 2019

日期Date: 2019年3月18-19日 星期一-星期二 Monday-Tuesday, March 18-19, 2019

地点Venue: 上海国际会议中心 Shanghai International Convention Center



Dr. Simon M. Sze
Honorary Chair Professor
NCTU



Dr. Yaoguo (Gary) Ding
Vice President, Technology
and Manufacturing Group
Intel



Dr. Min Cao
Vice President, Path-finding
TSMC



Dr. Evangelos Eleftheriou
Fellow, Neuromorphic
Computing
IBM

Topics to be addressed at CSTIC 2019 include, but are not limited to the following:

Symposium I: Device Engineering and Memory Technology

Symposium II: Lithography and Patterning

Symposium III: Dry & Wet Etch and Cleaning

Symposium IV: Thin Film, Plating and Process Integration

Symposium V: CMP and Post-Polish Cleaning

Symposium VI: Metrology, Reliability and Testing

Symposium VII: Packaging and Assembly

Symposium VIII: MEMS, Sensors and Emerging Semiconductor Technologies

Symposium IX: Design and Automation of Circuits and Systems

Training Courses

14:00-17:00, Tuesday, March 19, 2019

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the process chamber to increase front-
end tool uptime and output



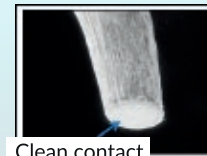
无需开工艺腔的在线吸盘清洁方案，
提升晶圆段设备机时和产出

Probe Card Clean & Test Cell Conditioner

Visit booth N2#2409 of Zen Voce (Suzhou) Corporation
请莅临博磊精密设备（苏州）有限公司 展台N2#2409



Probe Card Clean / 探针卡清洁材料



Clean contact
surface

Cantilevered
Probe Tips
with on-line
cleaning with
ITS Material

Designed to clean and maintain the probe tips
shape with minimal wear

以最小的磨损清洁测试针并
同时有效维持针尖形状

Test Cell Conditioner / 测试插座清洁材料

Online final test contactor cleaning to control contact
resistance and maximize contactor electrical performance

在线终测插座清洁方案，有效控制接触阻抗，优化插座电气性能

